

Fig. 1

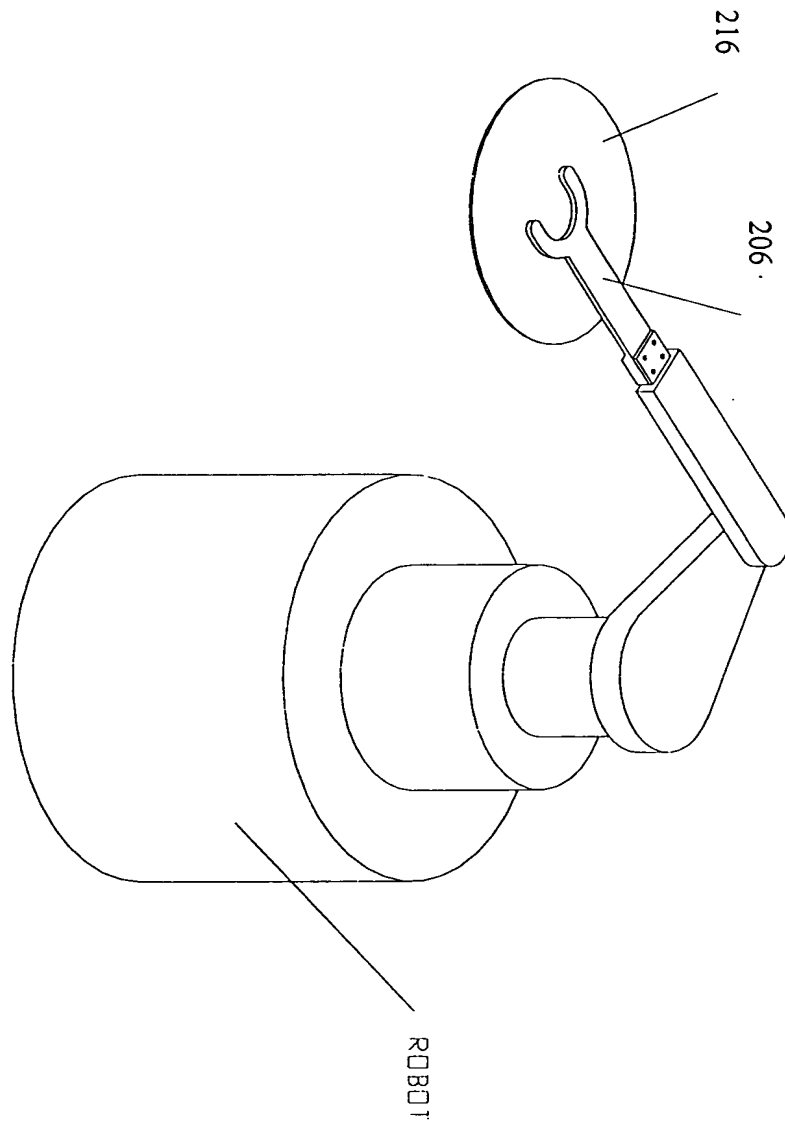


Fig. 2

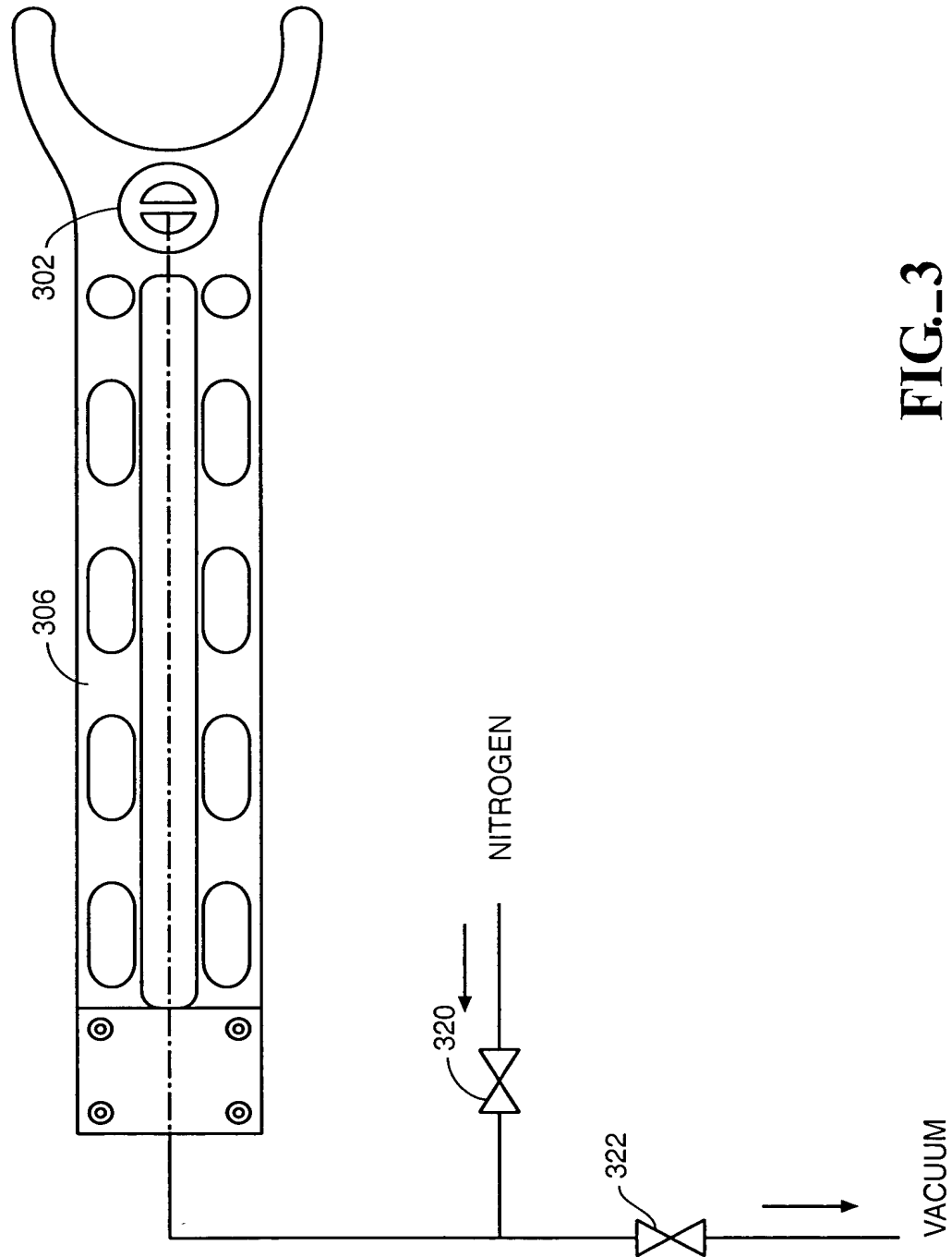
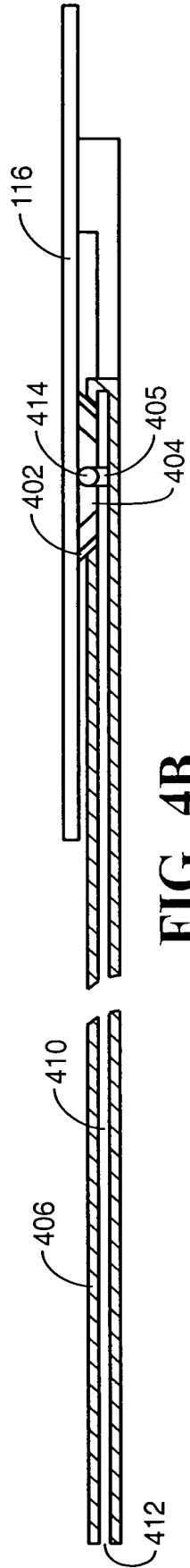
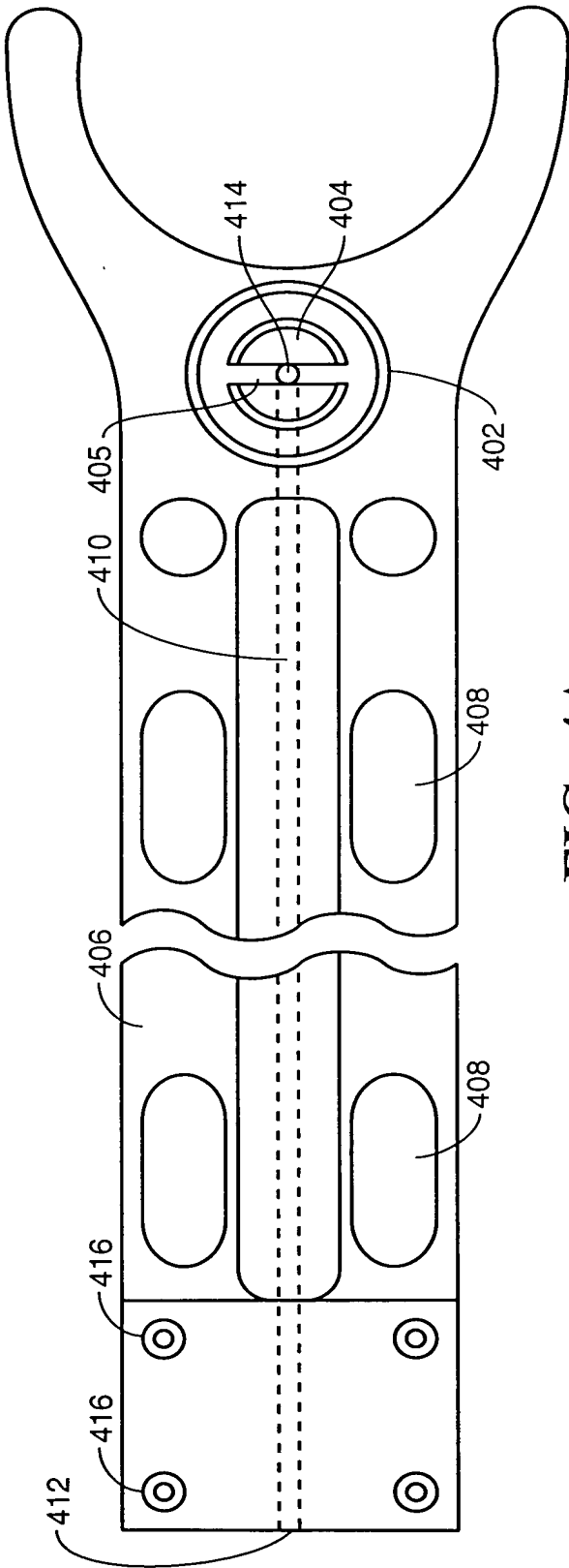
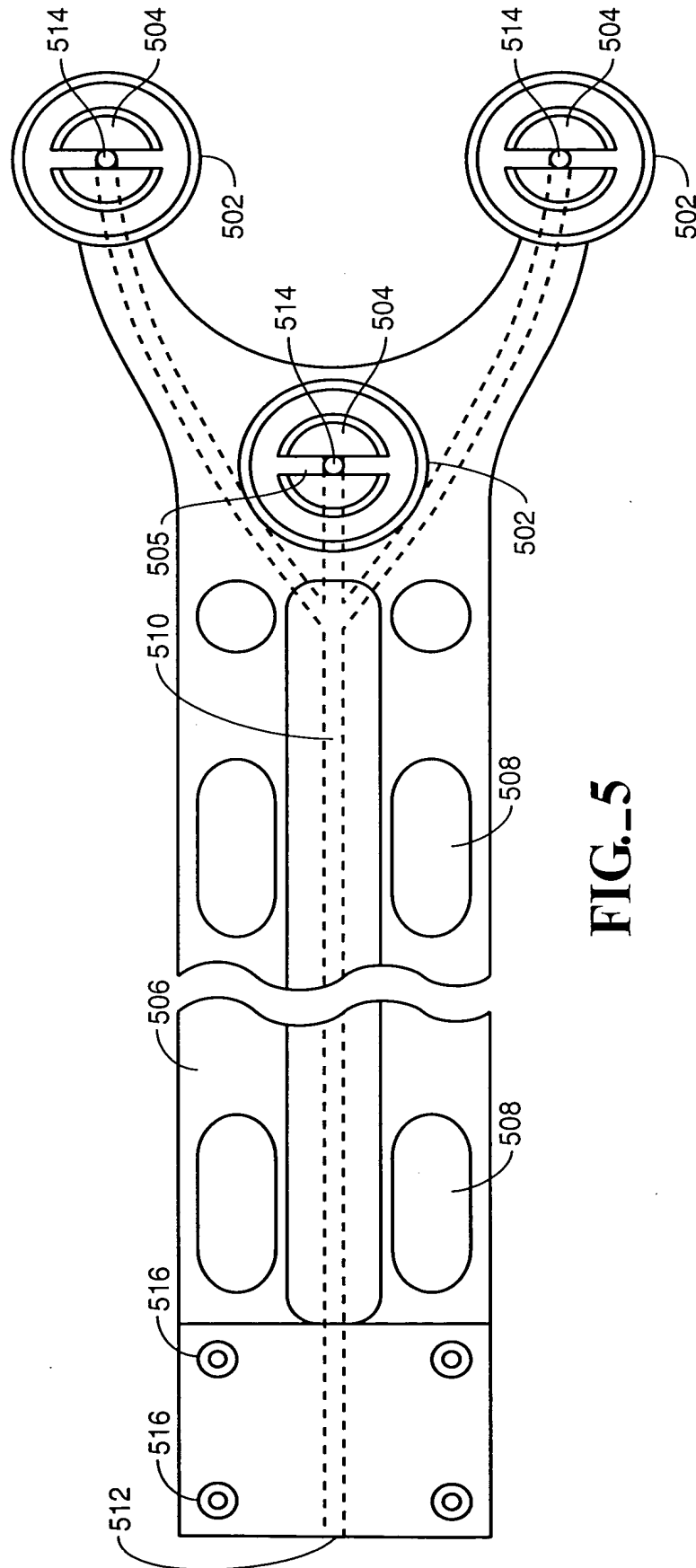


FIG. 3





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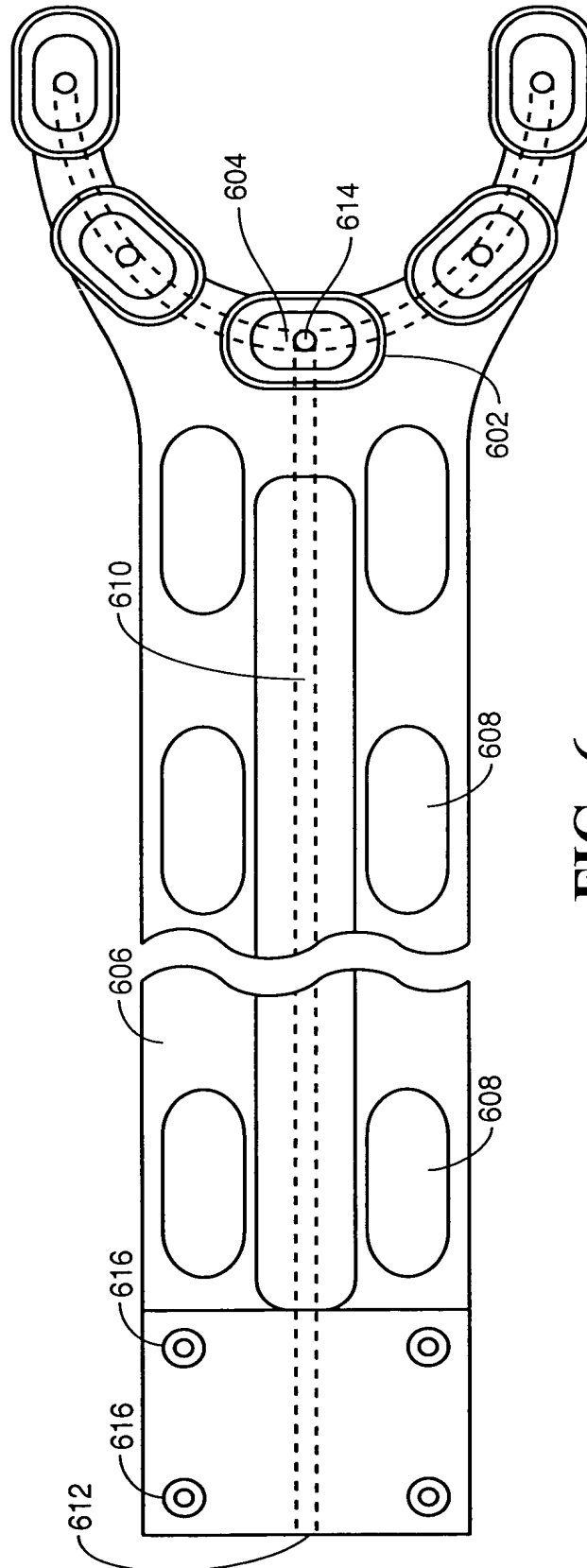


FIG. 6

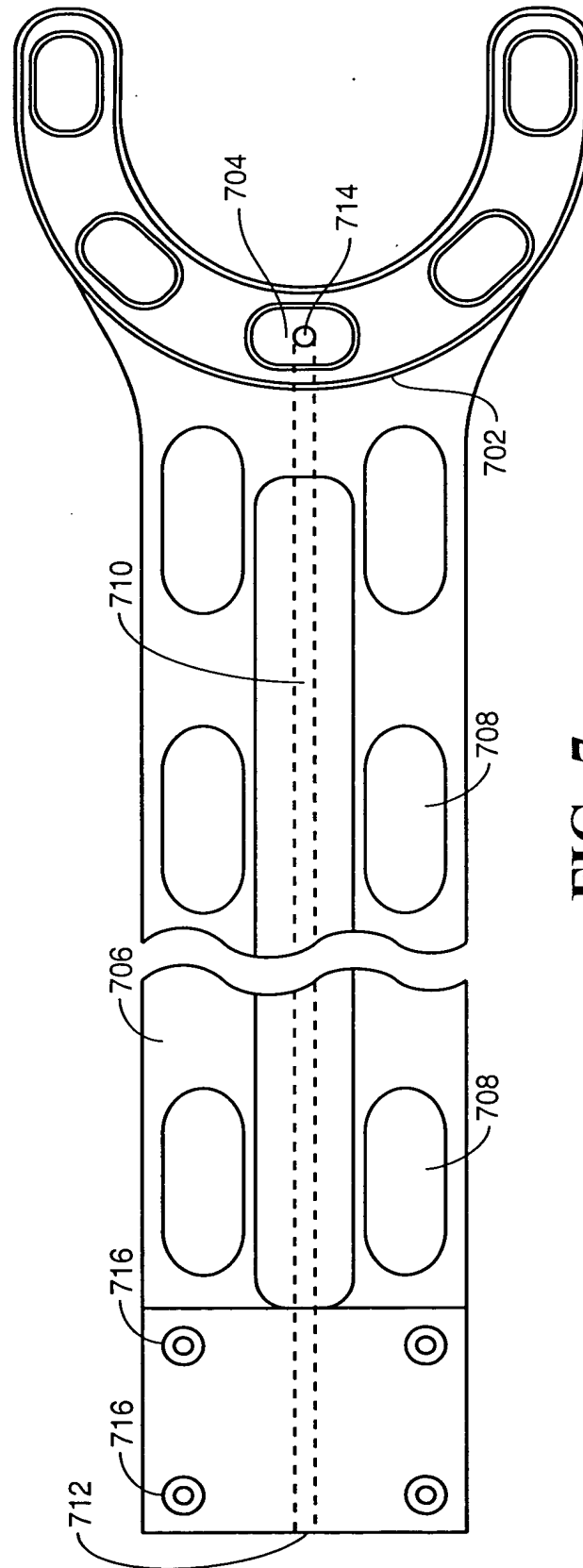


FIG. 7

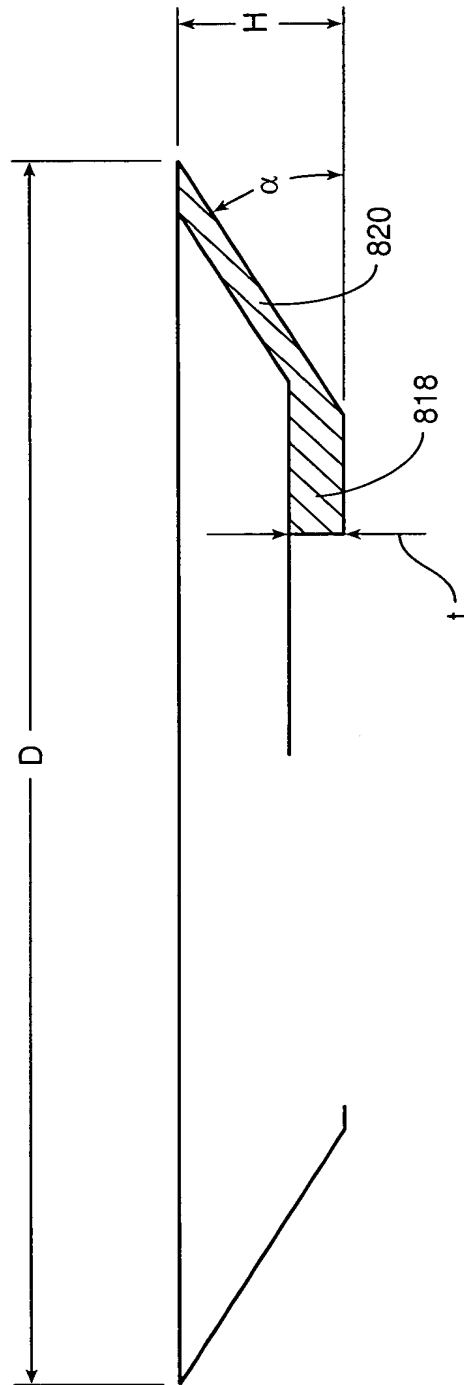


FIG._8

Fig. 9A

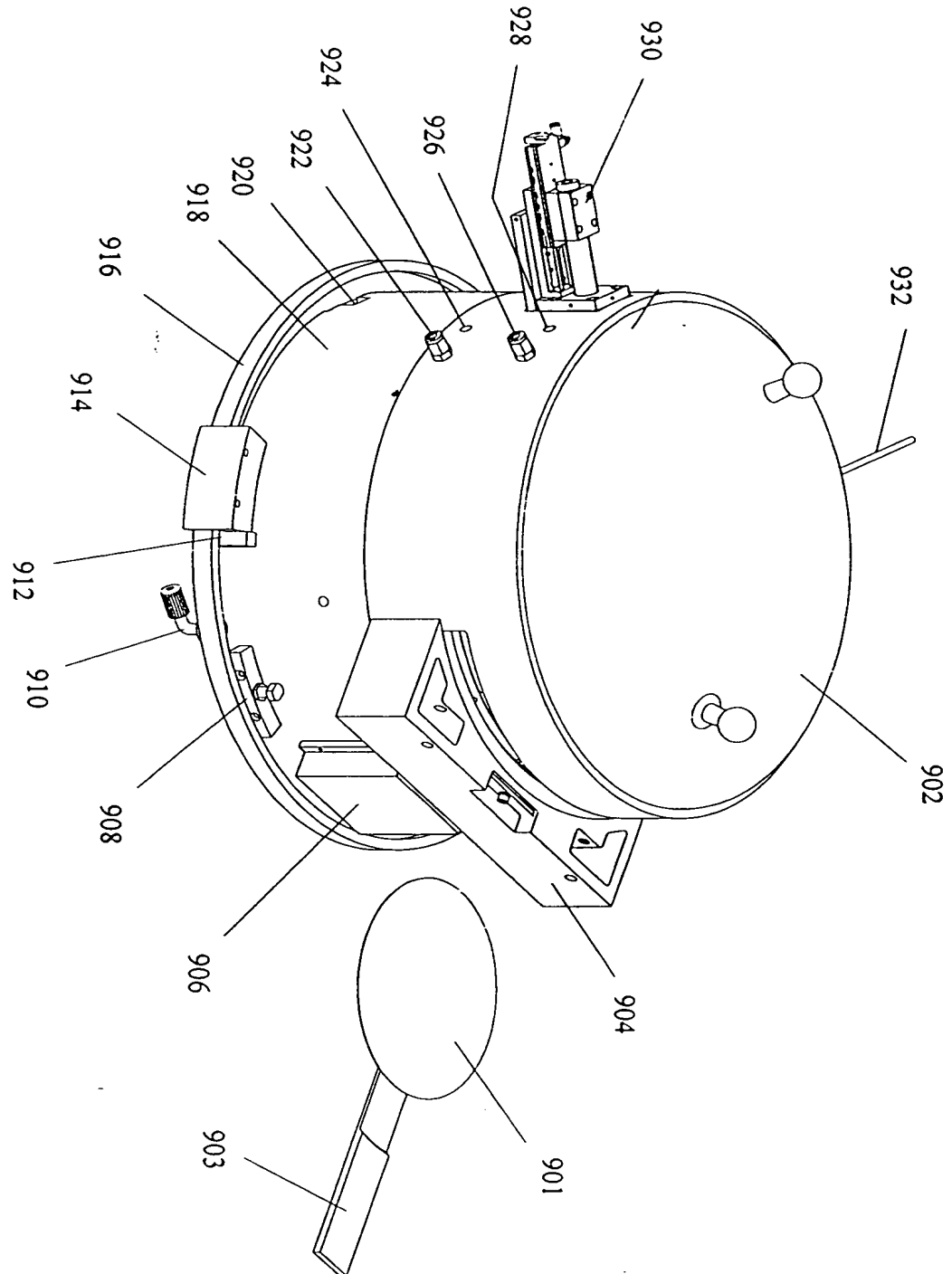


Fig. 9B

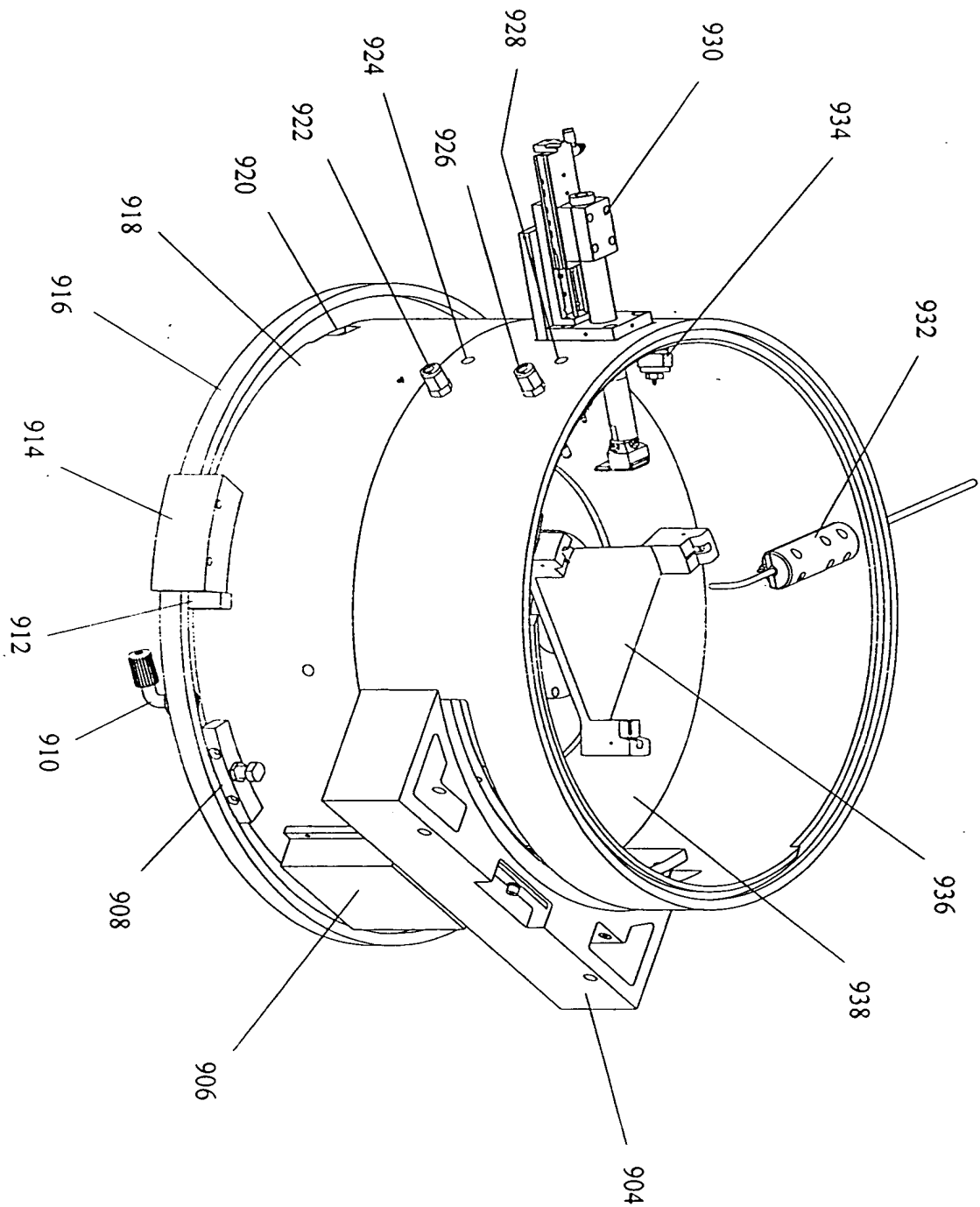
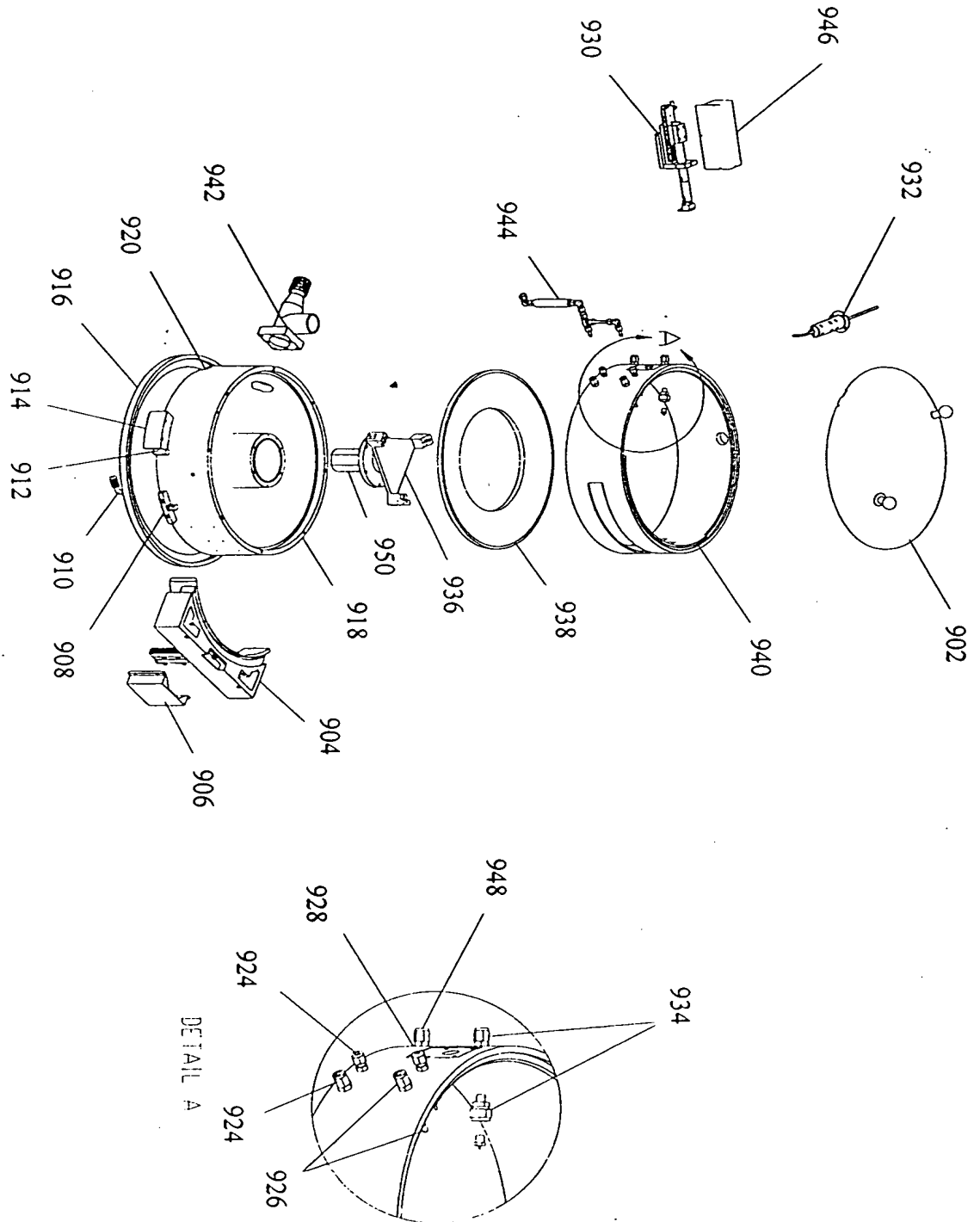


Fig. 9C



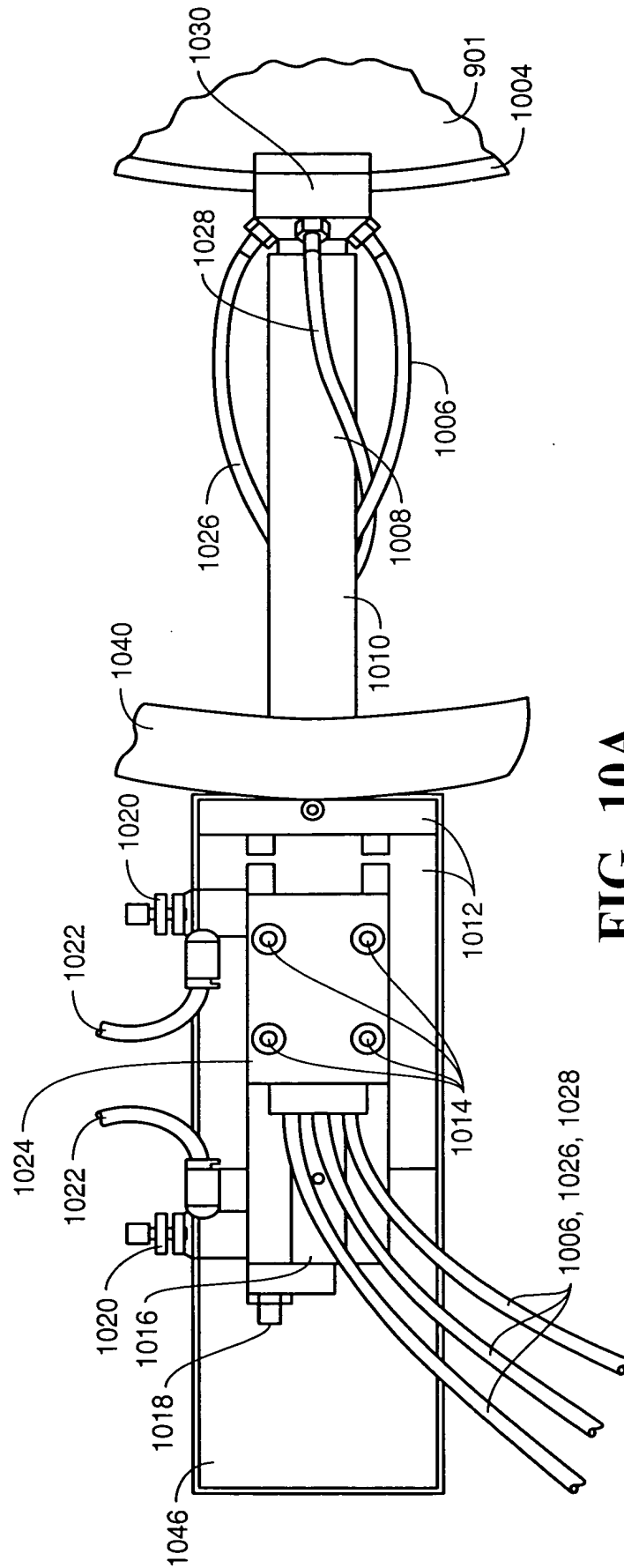


FIG. 10A

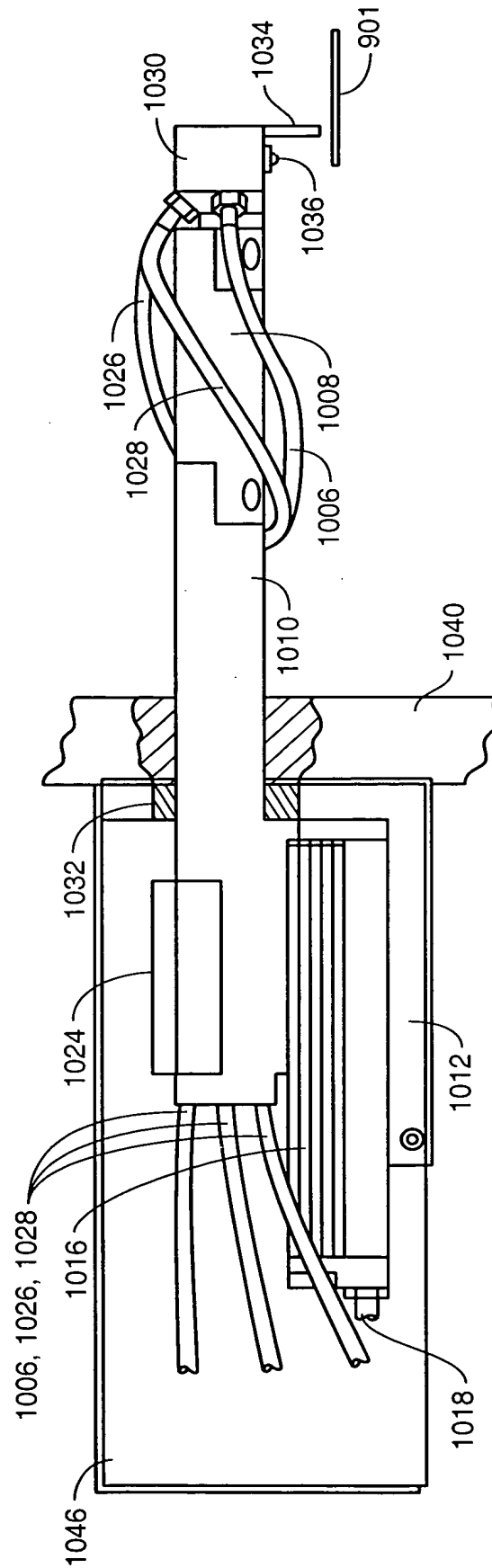


FIG. 10B

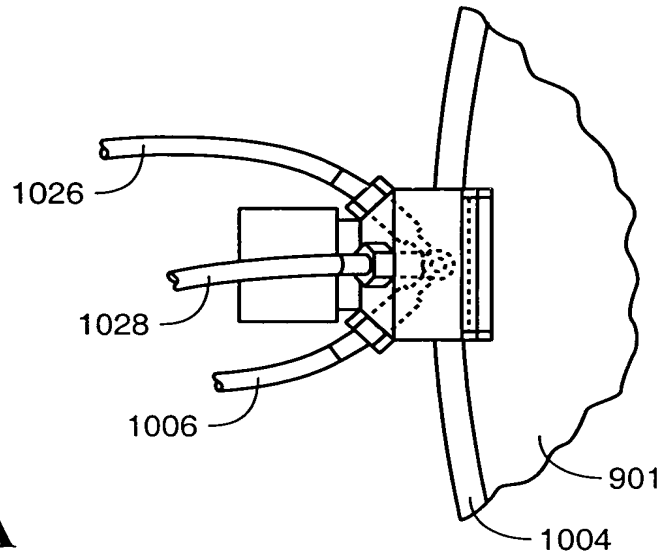
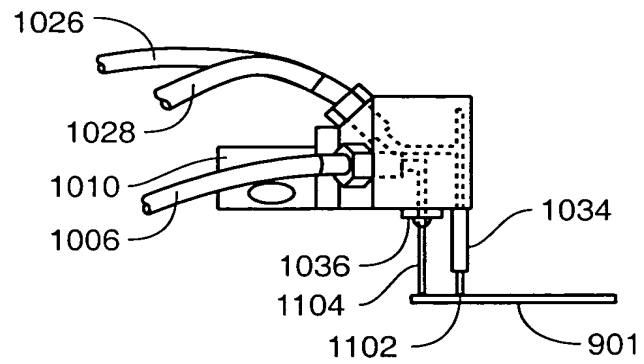
**FIG._11A****FIG._11B**

FIG._11C

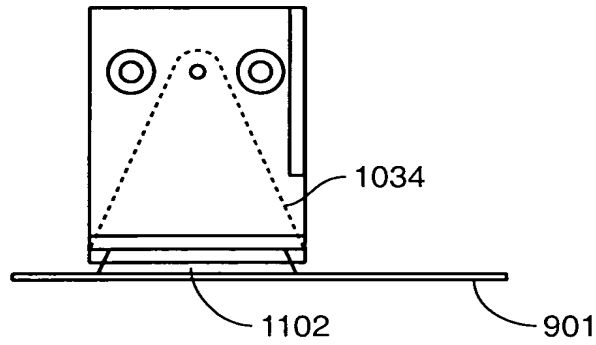
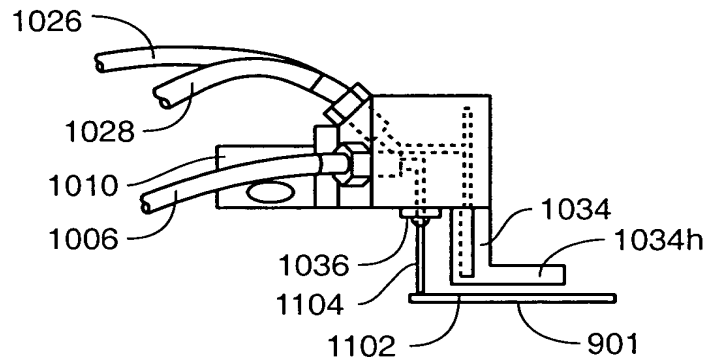
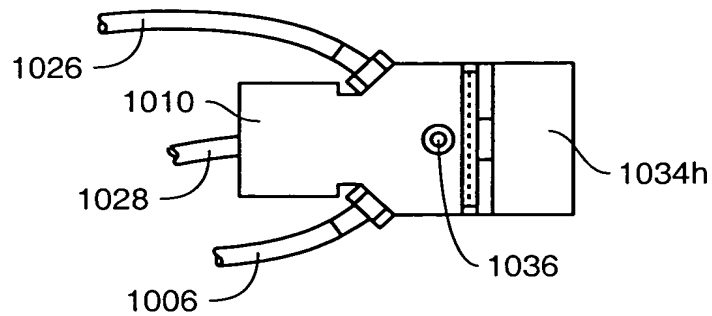
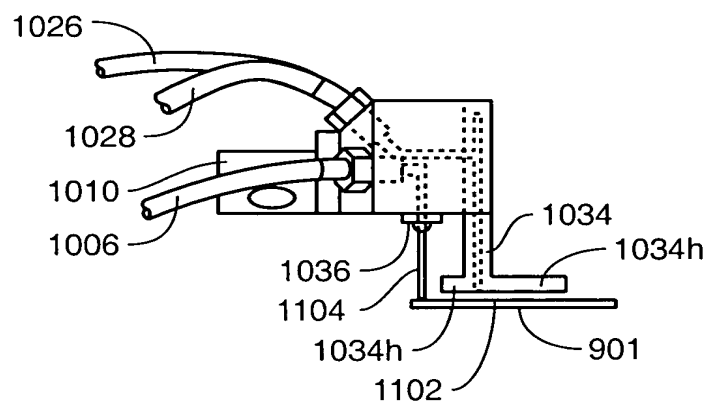


FIG._11D



**FIG._11E****FIG._11F**

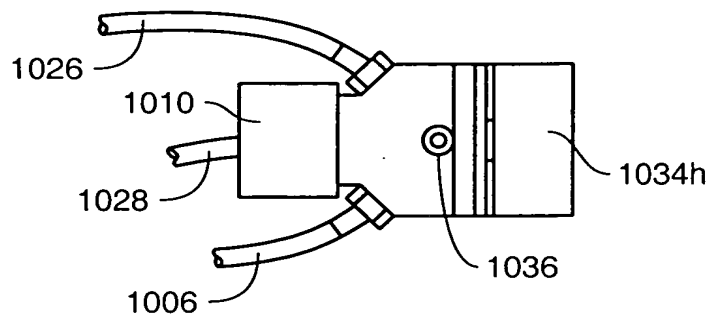


FIG. 11G

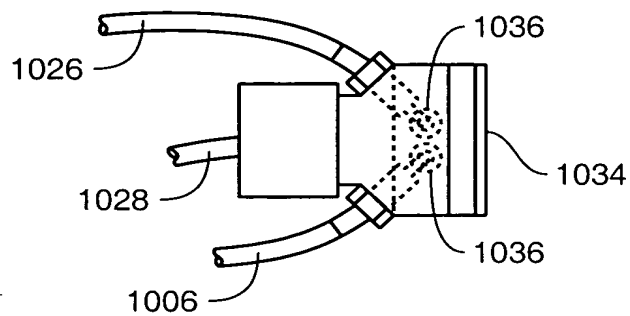


FIG. 11H

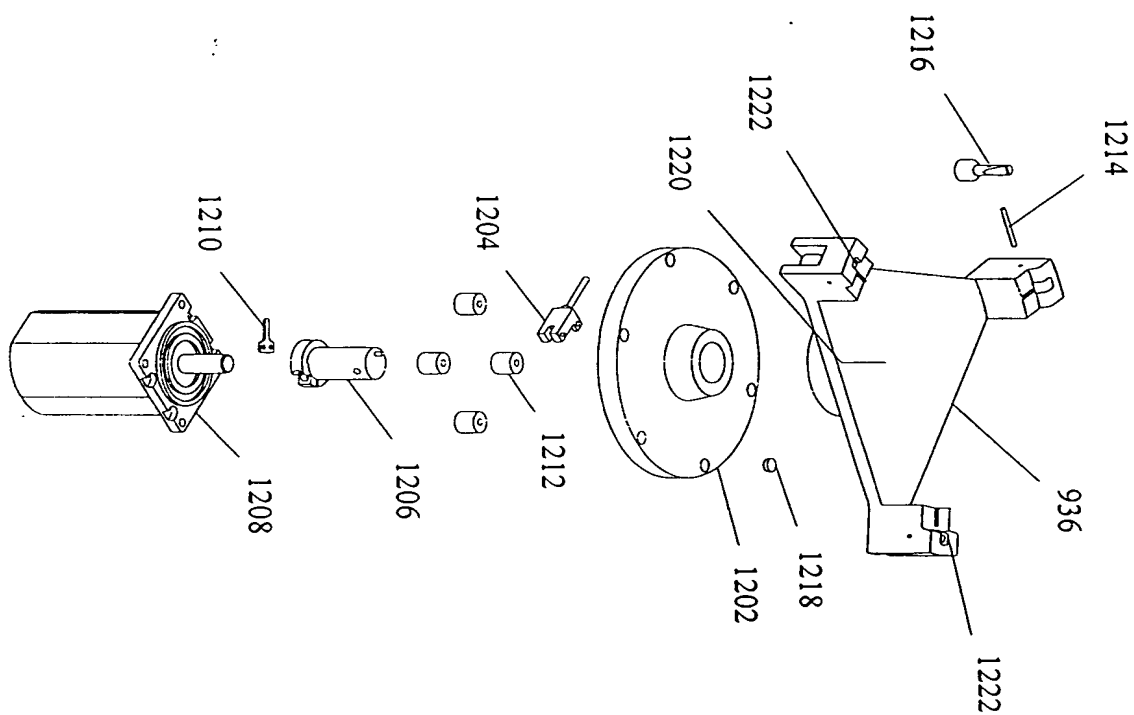
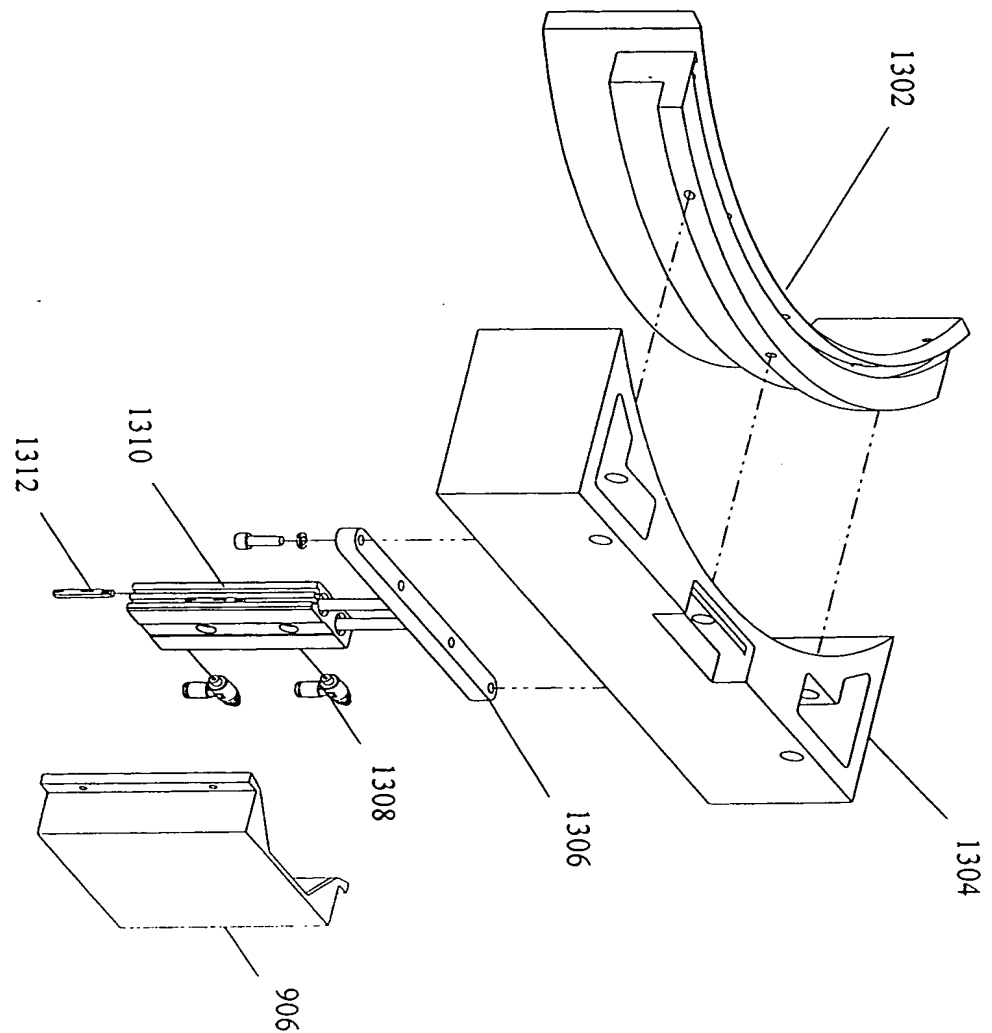


Fig. 12

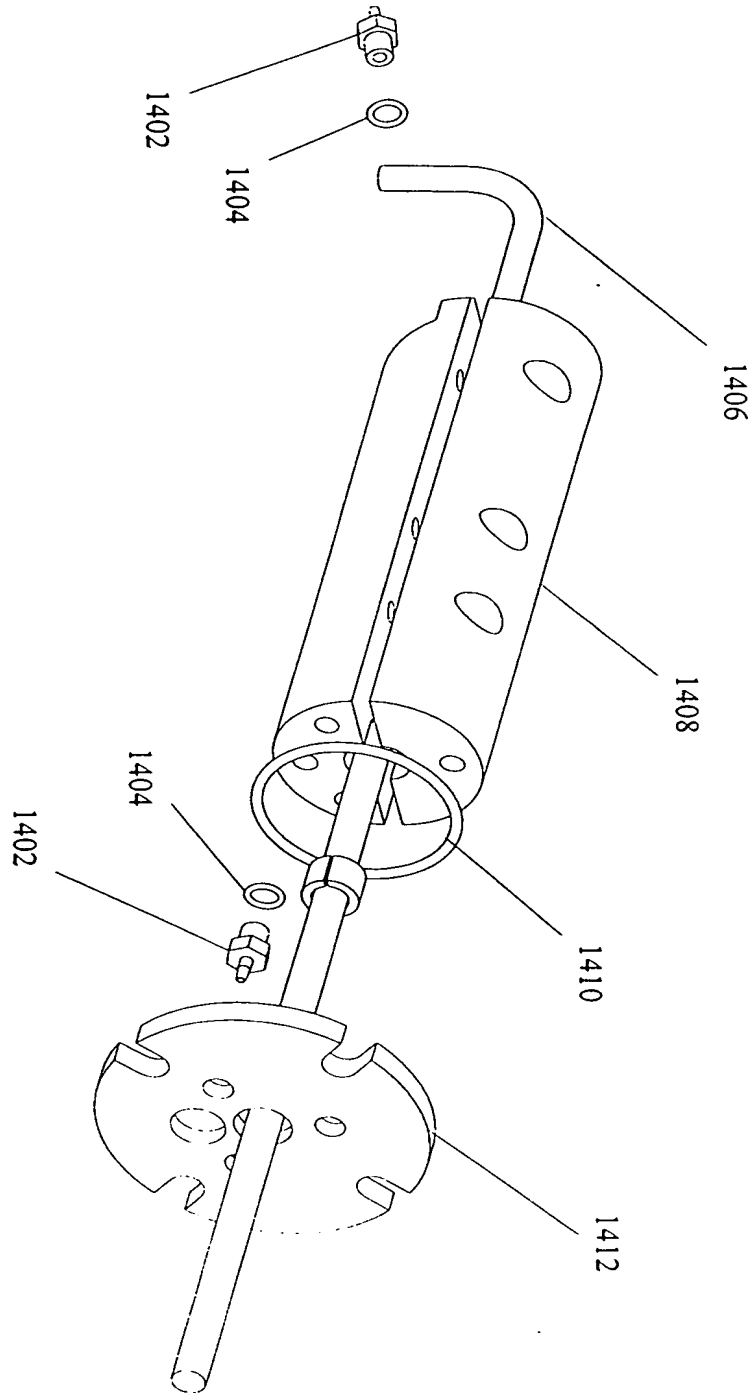
Fig. 13



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Fig. 14



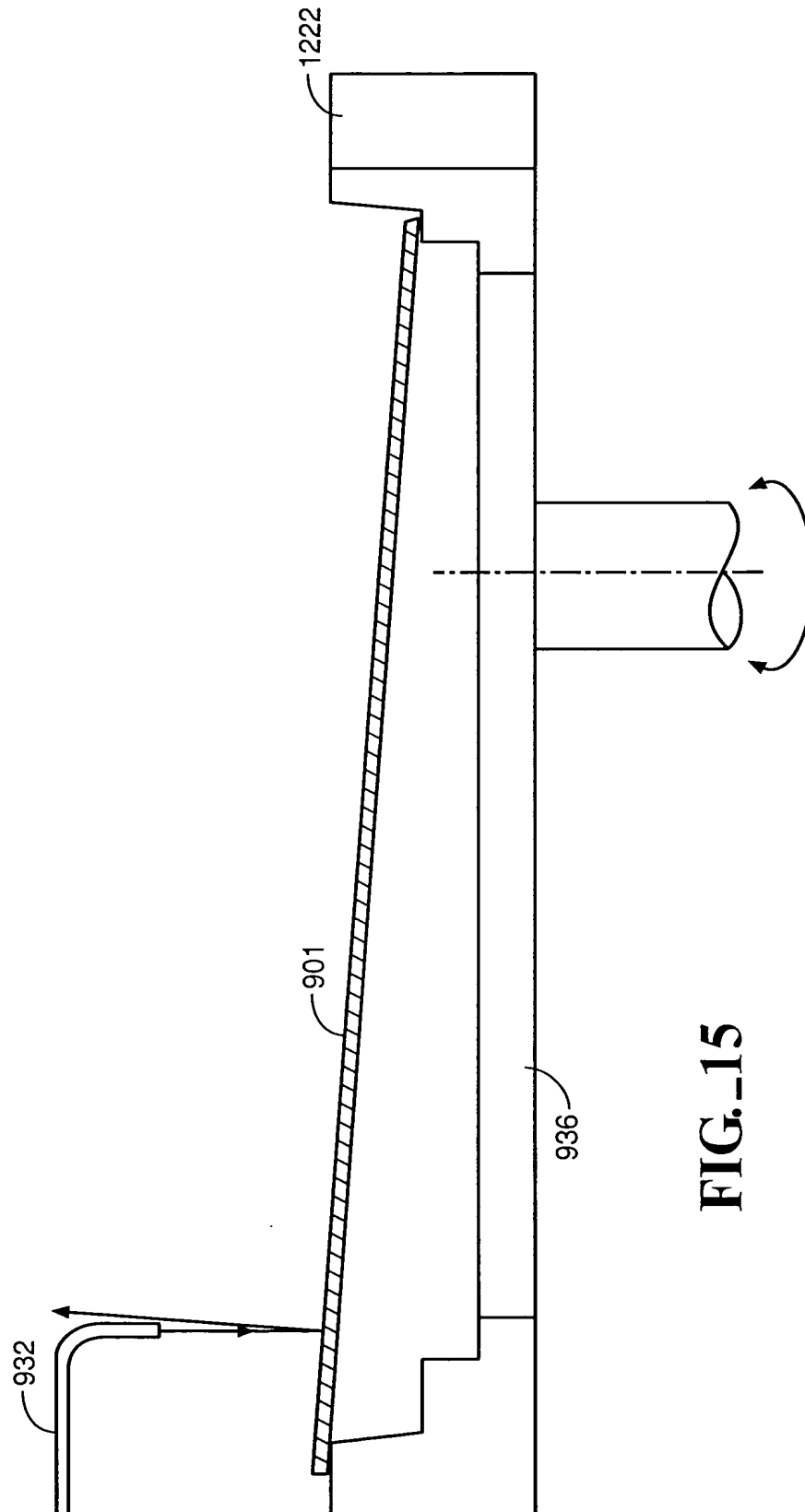


FIG. 15

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Fig. 16A

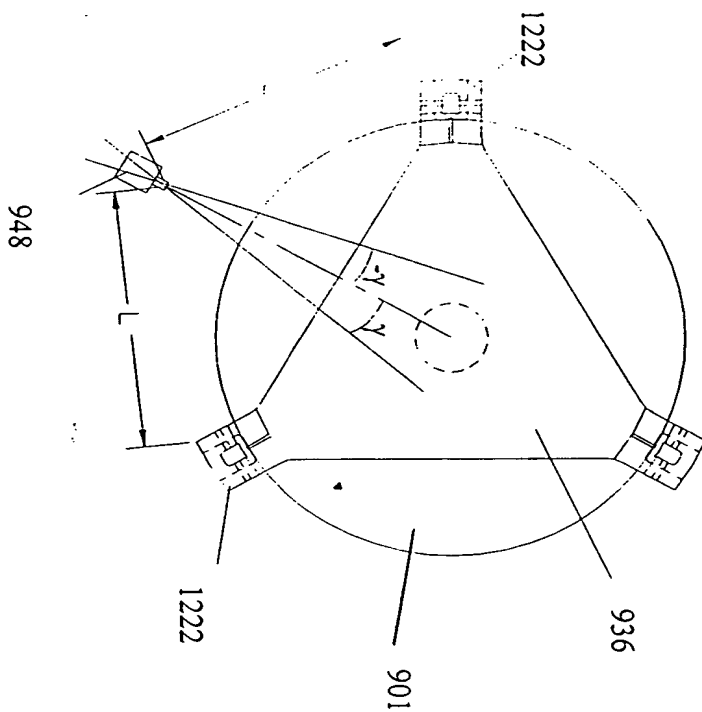


Fig. 16B

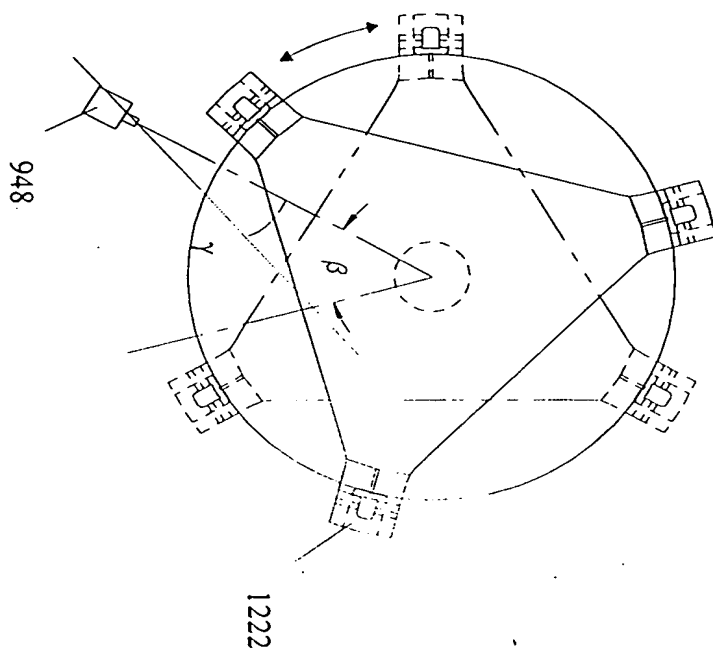


Fig. 16C

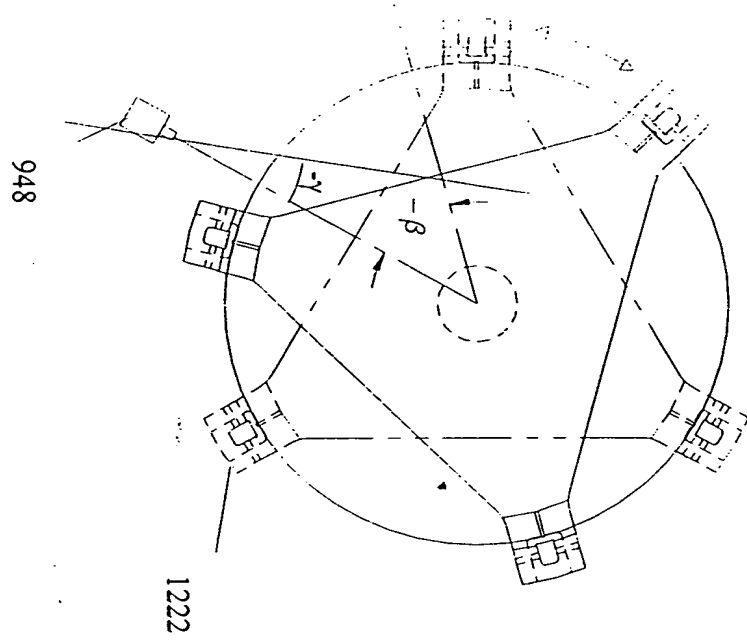
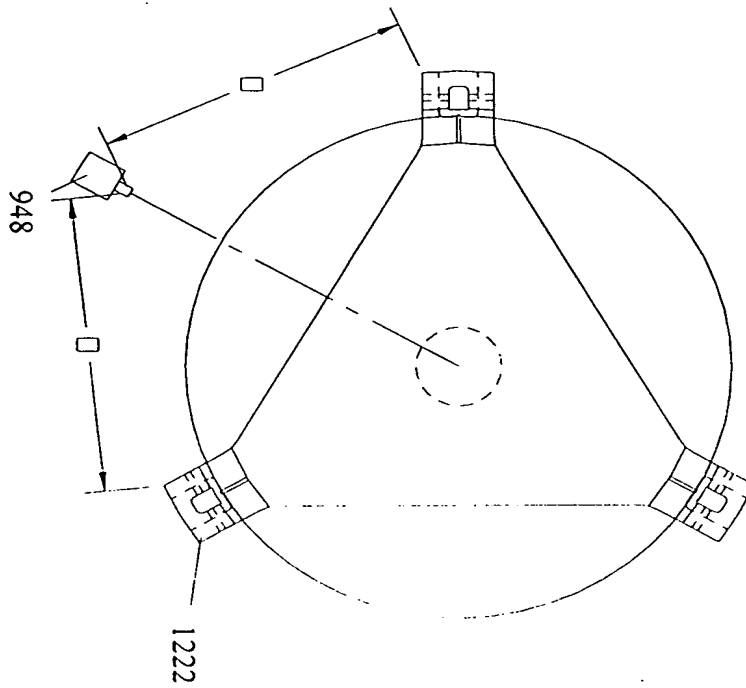


Fig. 17A



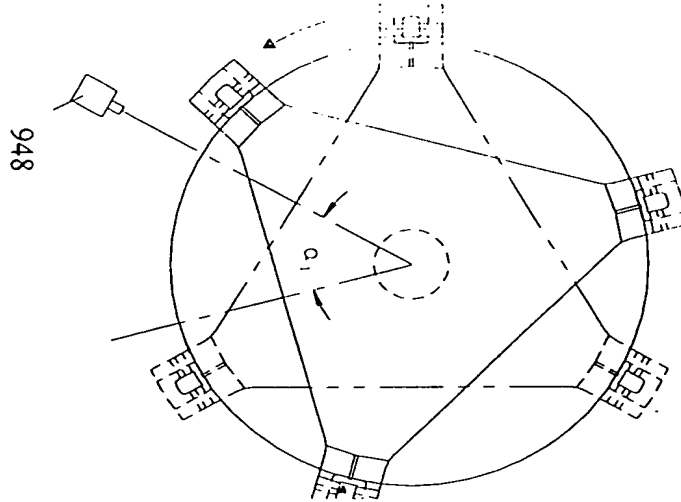


Fig. 17B

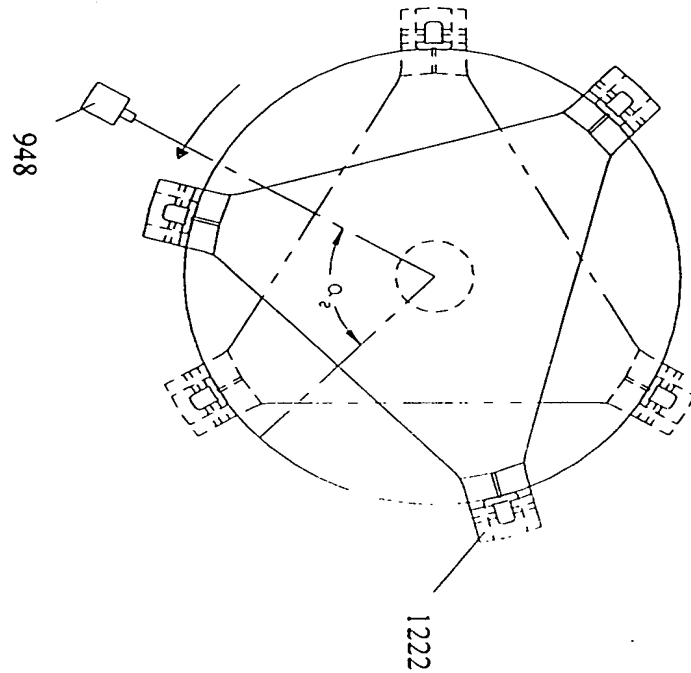


Fig. 17C

Fig. 18

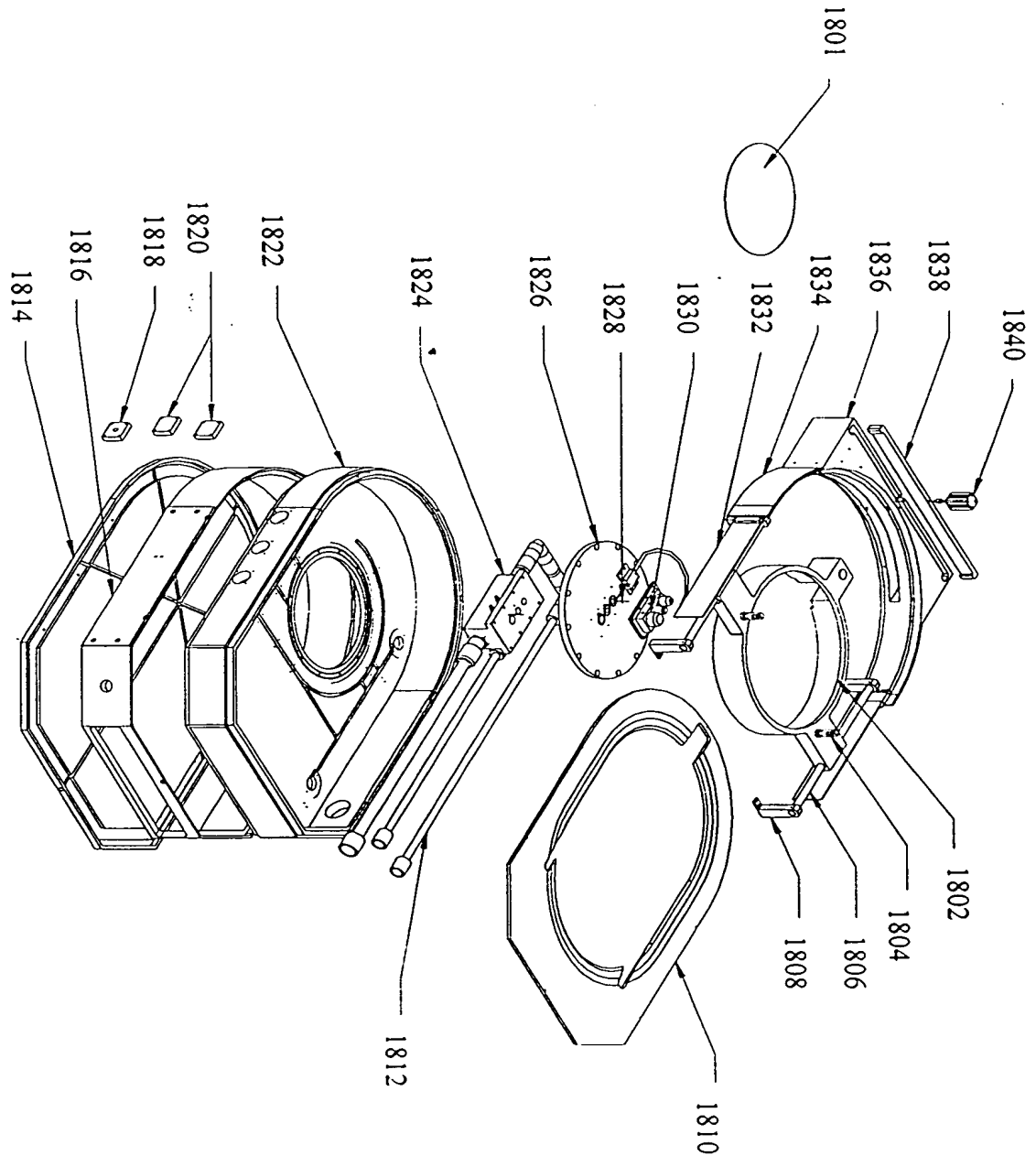


Fig. 19

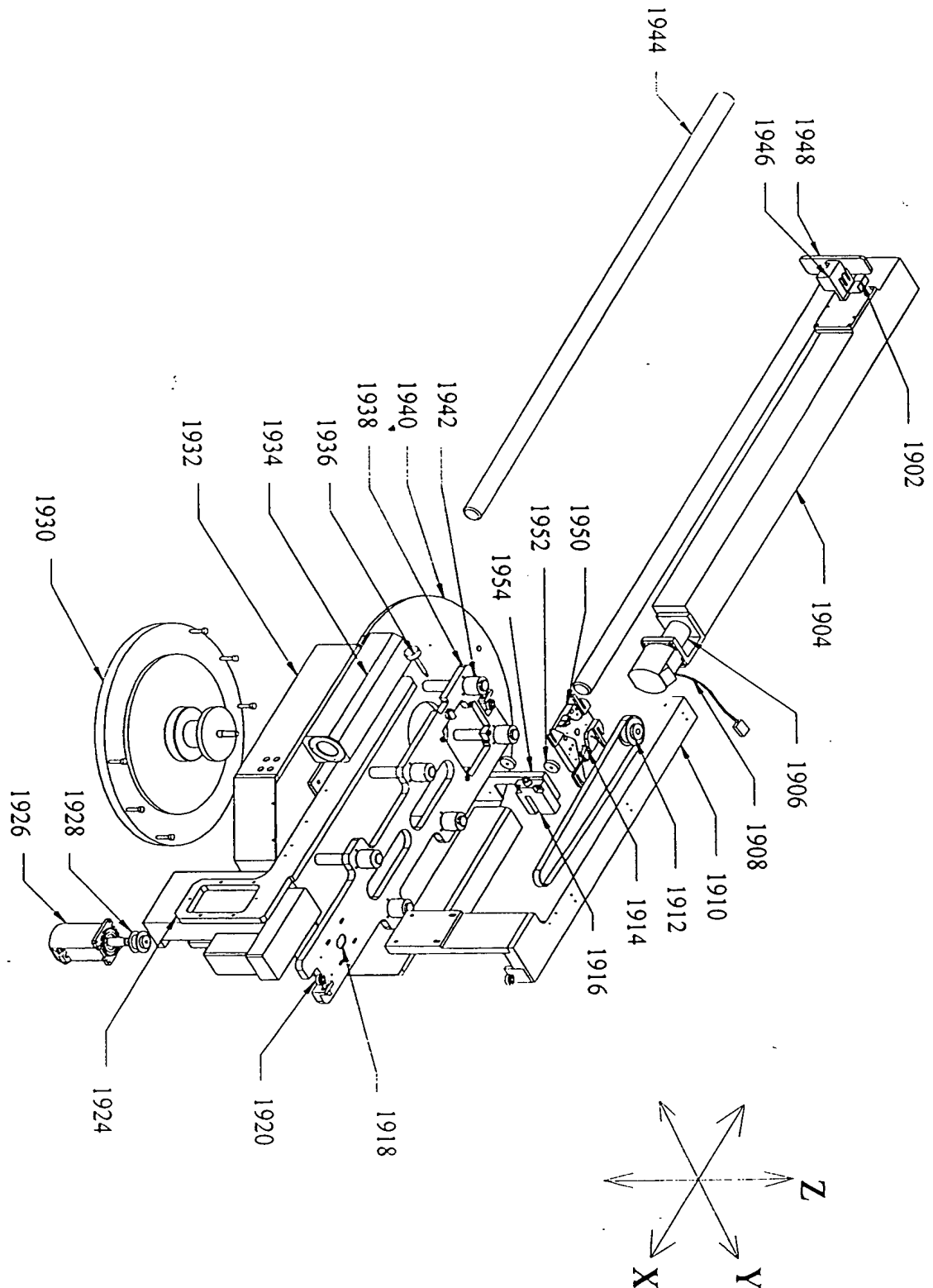
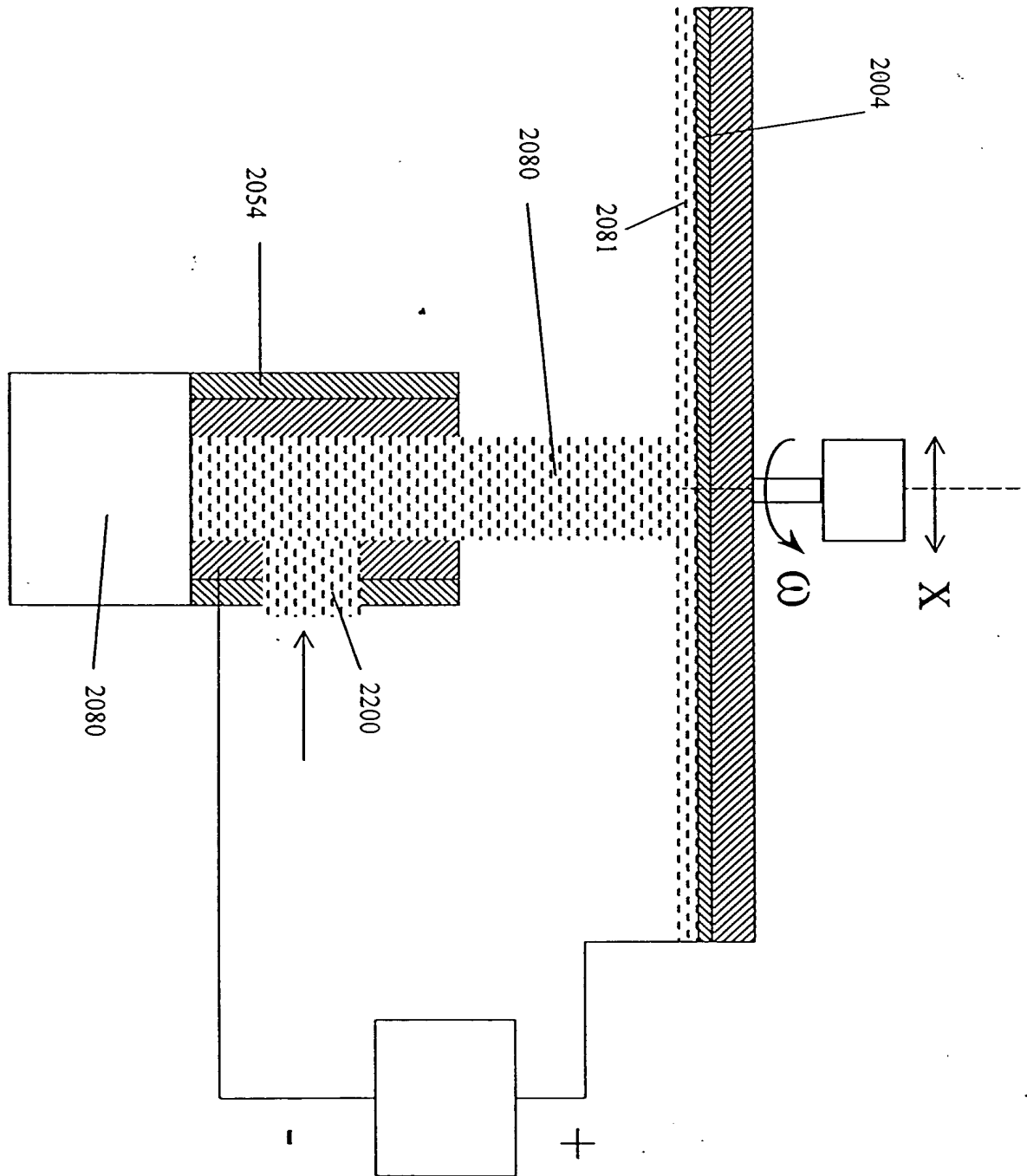


Fig. 20



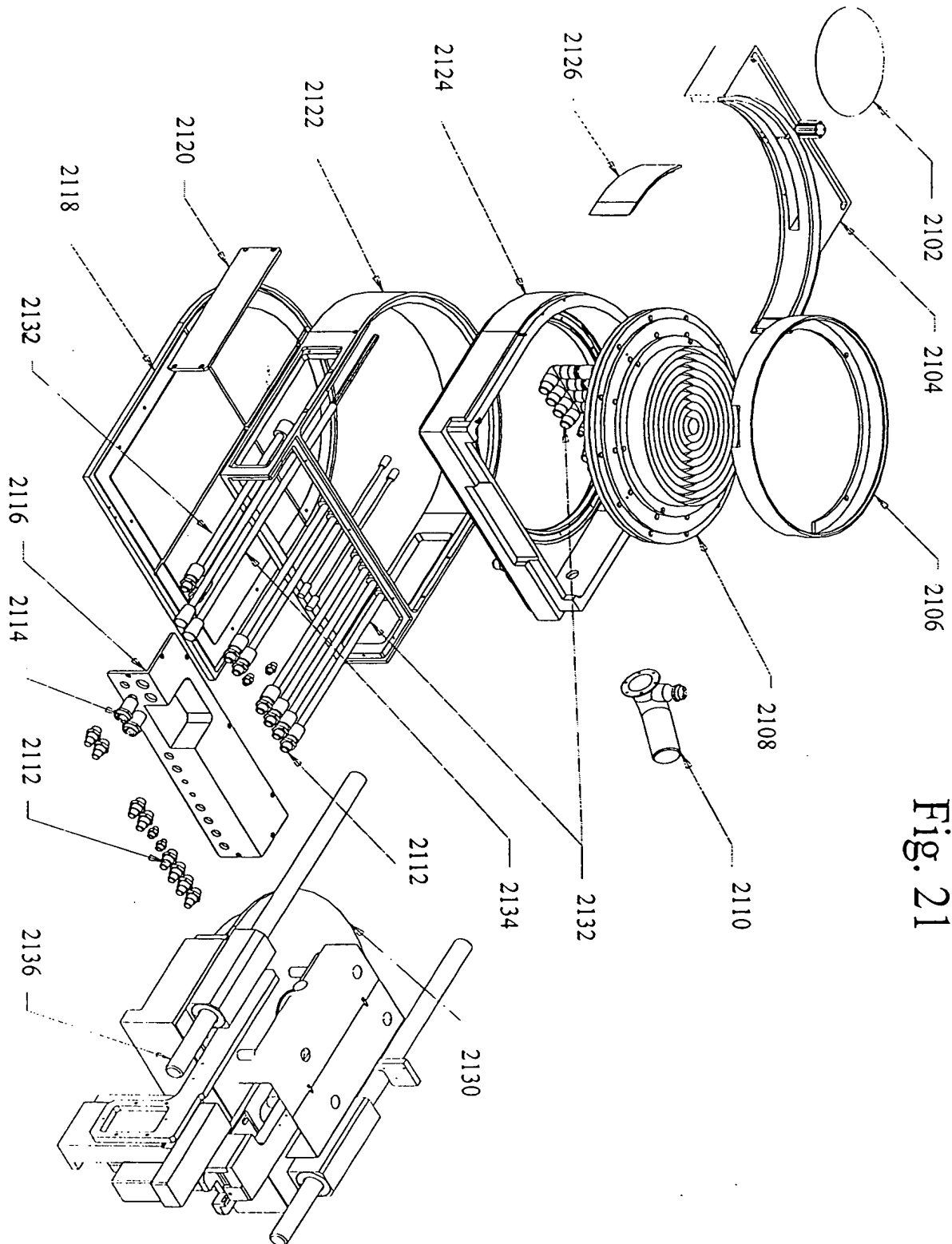


Fig. 21

Fig. 22

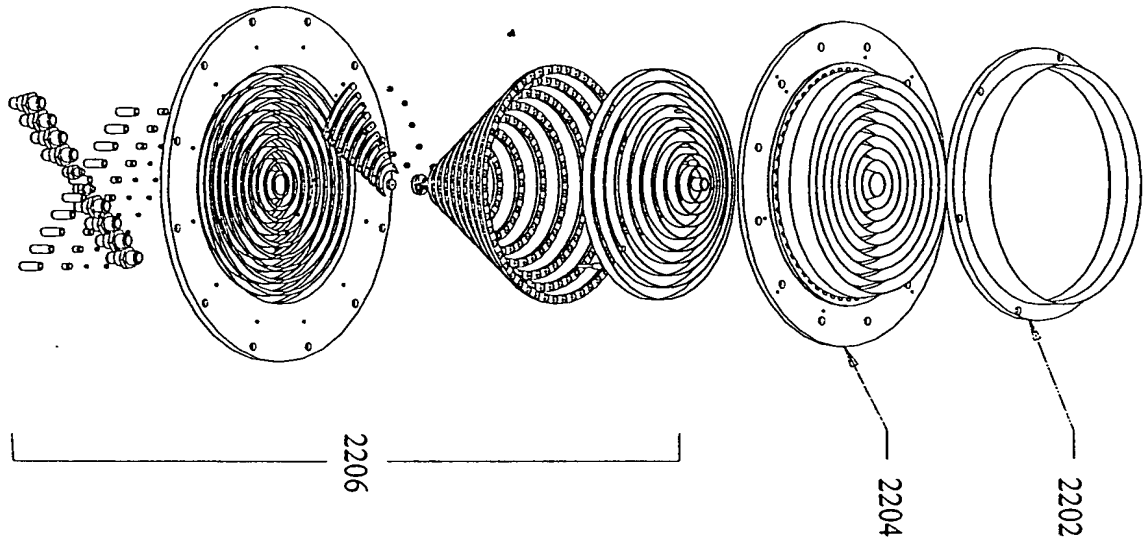


Fig. 23

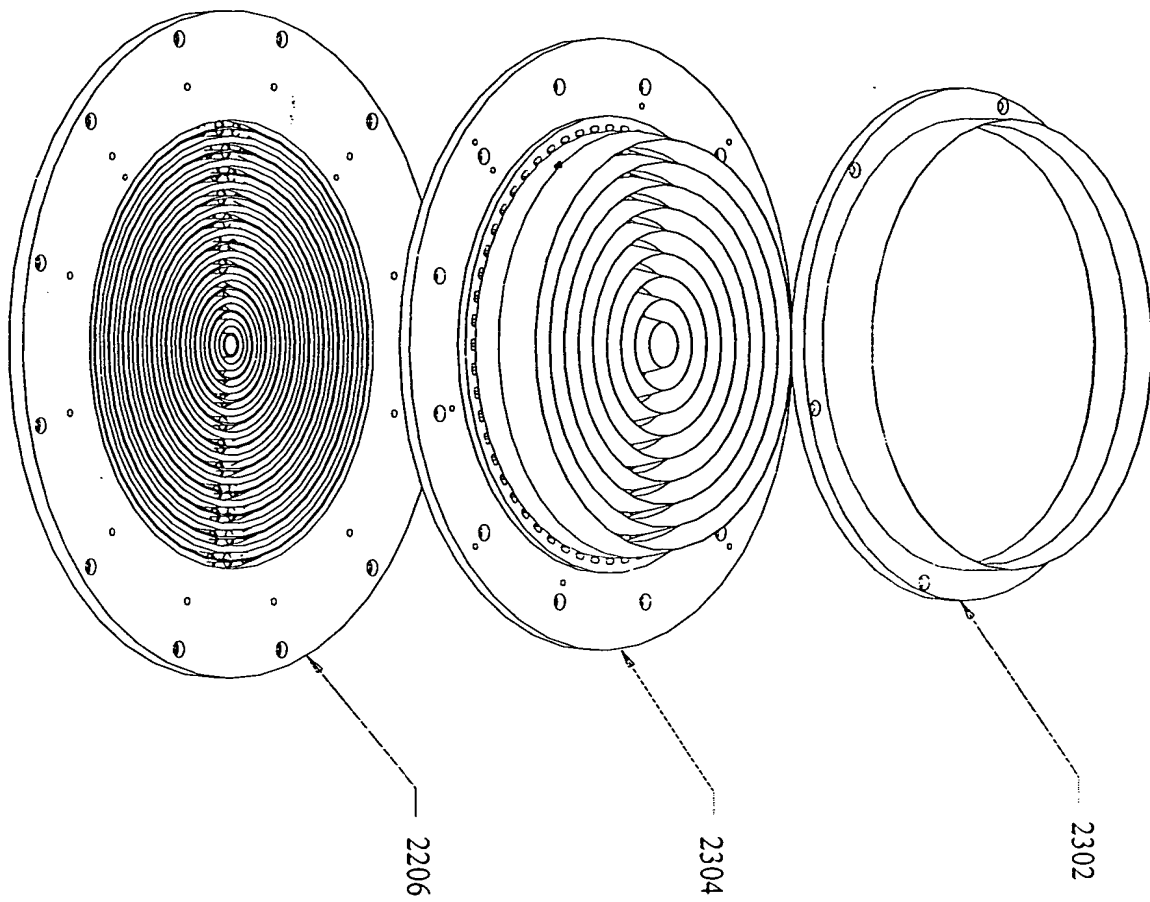
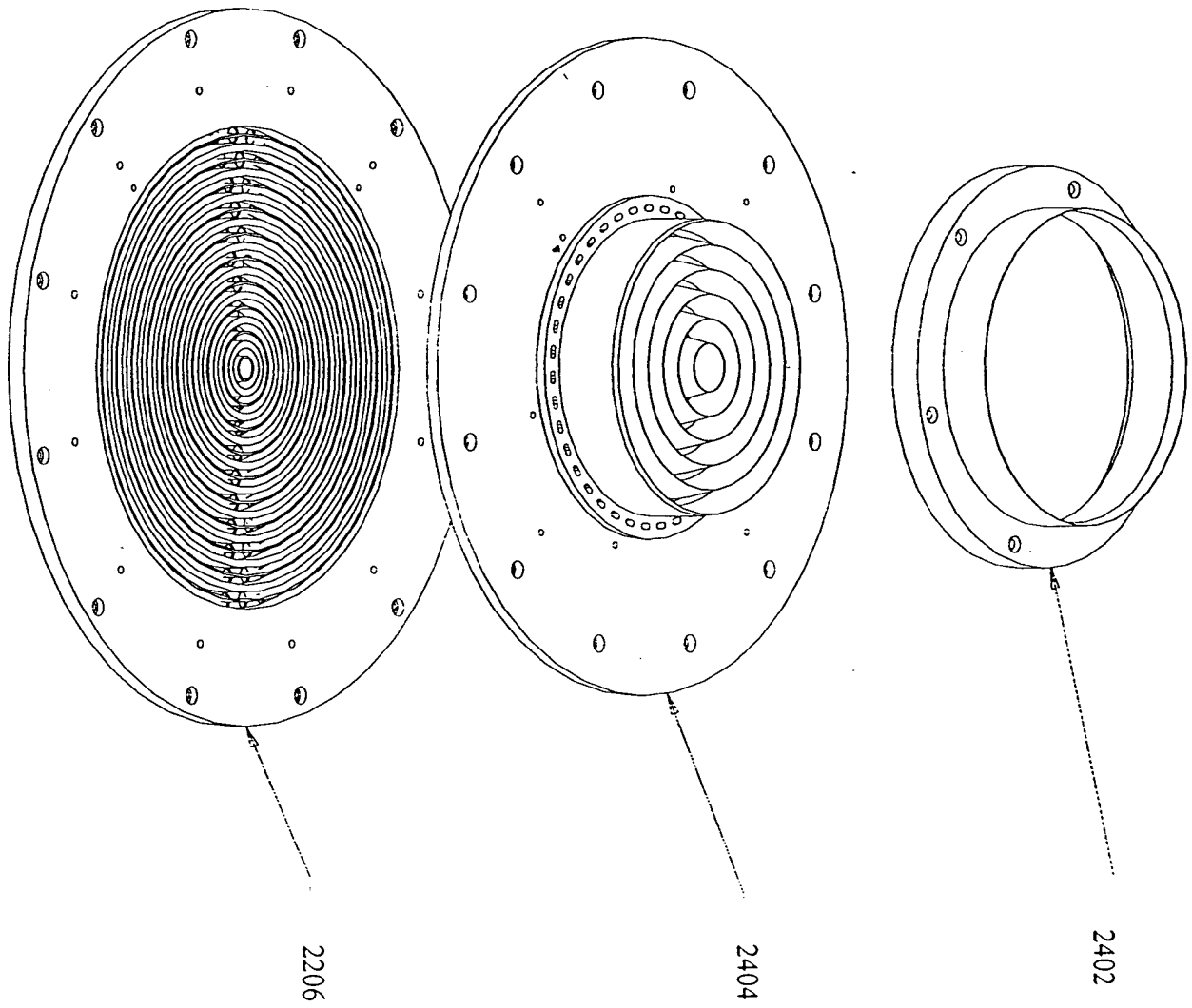


Fig. 24



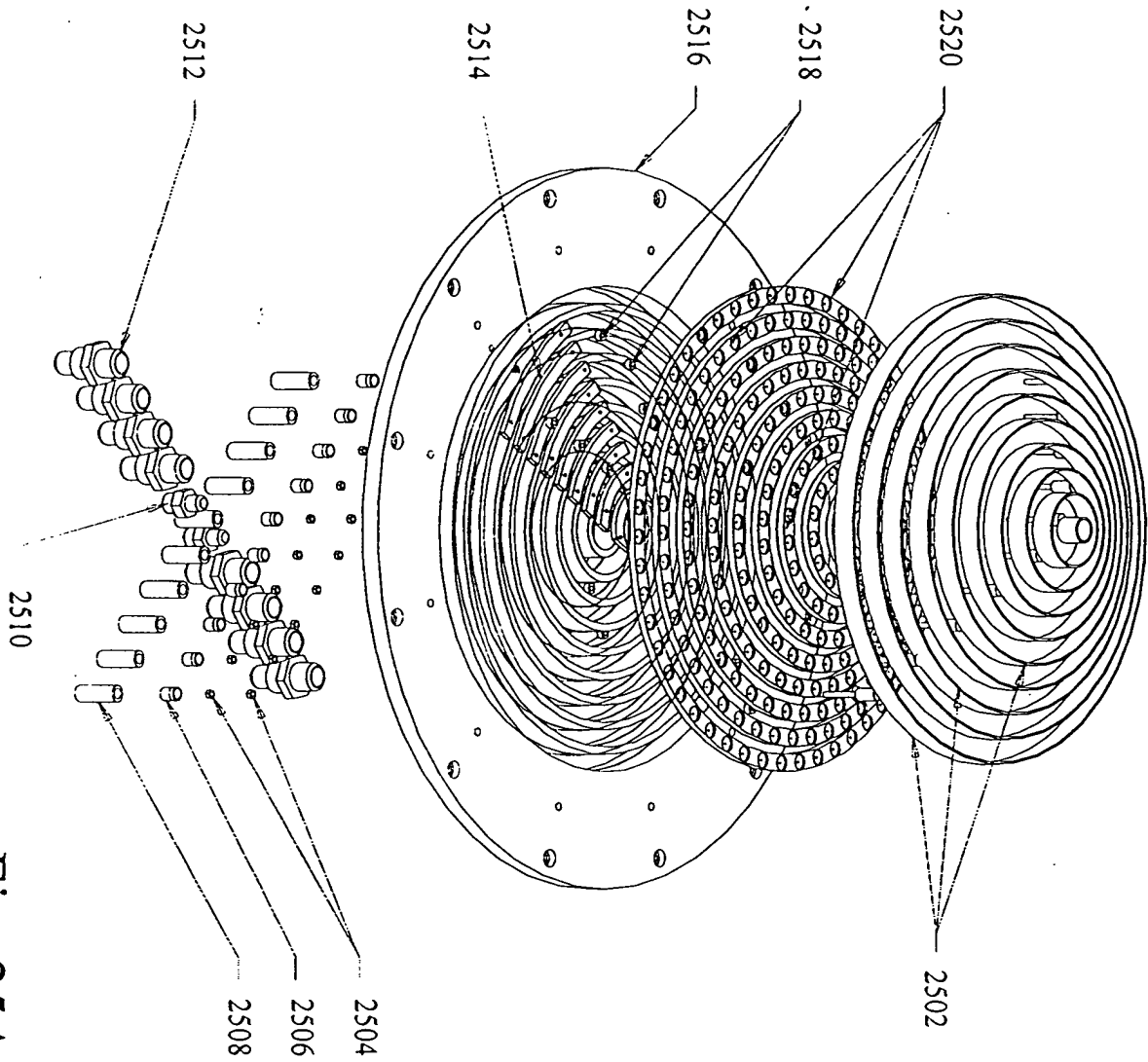


Fig. 25A

Fig. 25B

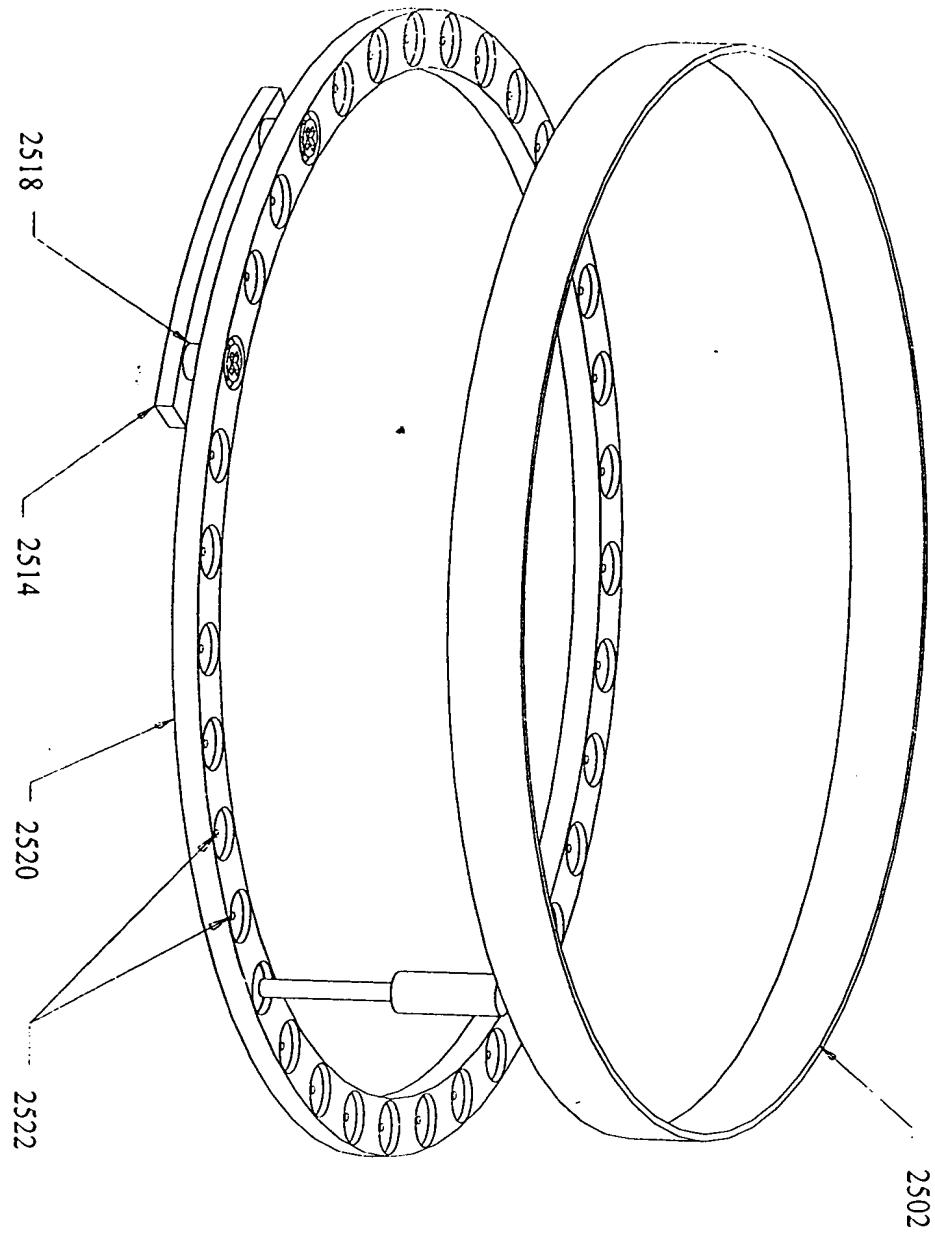


Fig. 25C

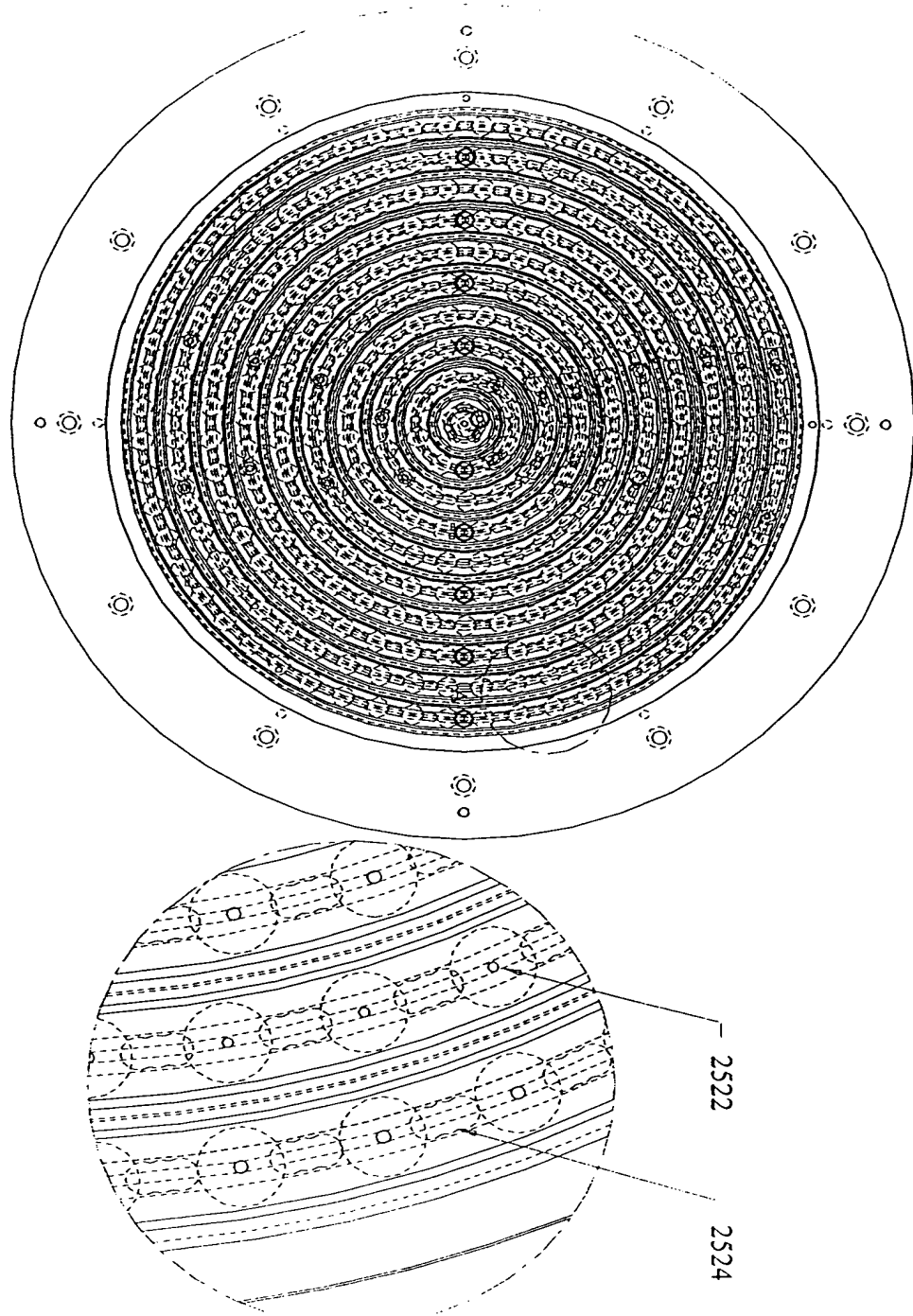
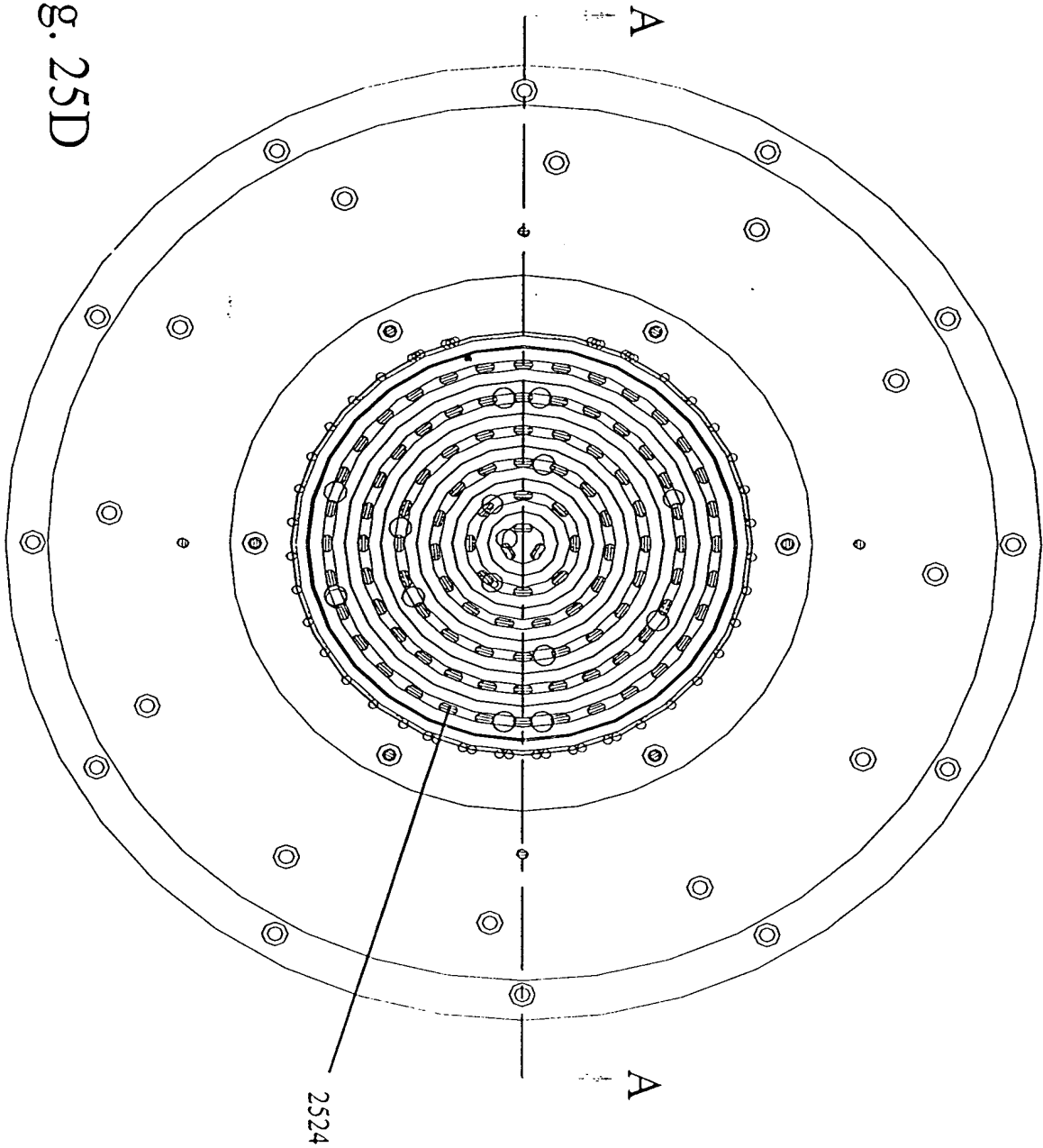


Fig. 25D



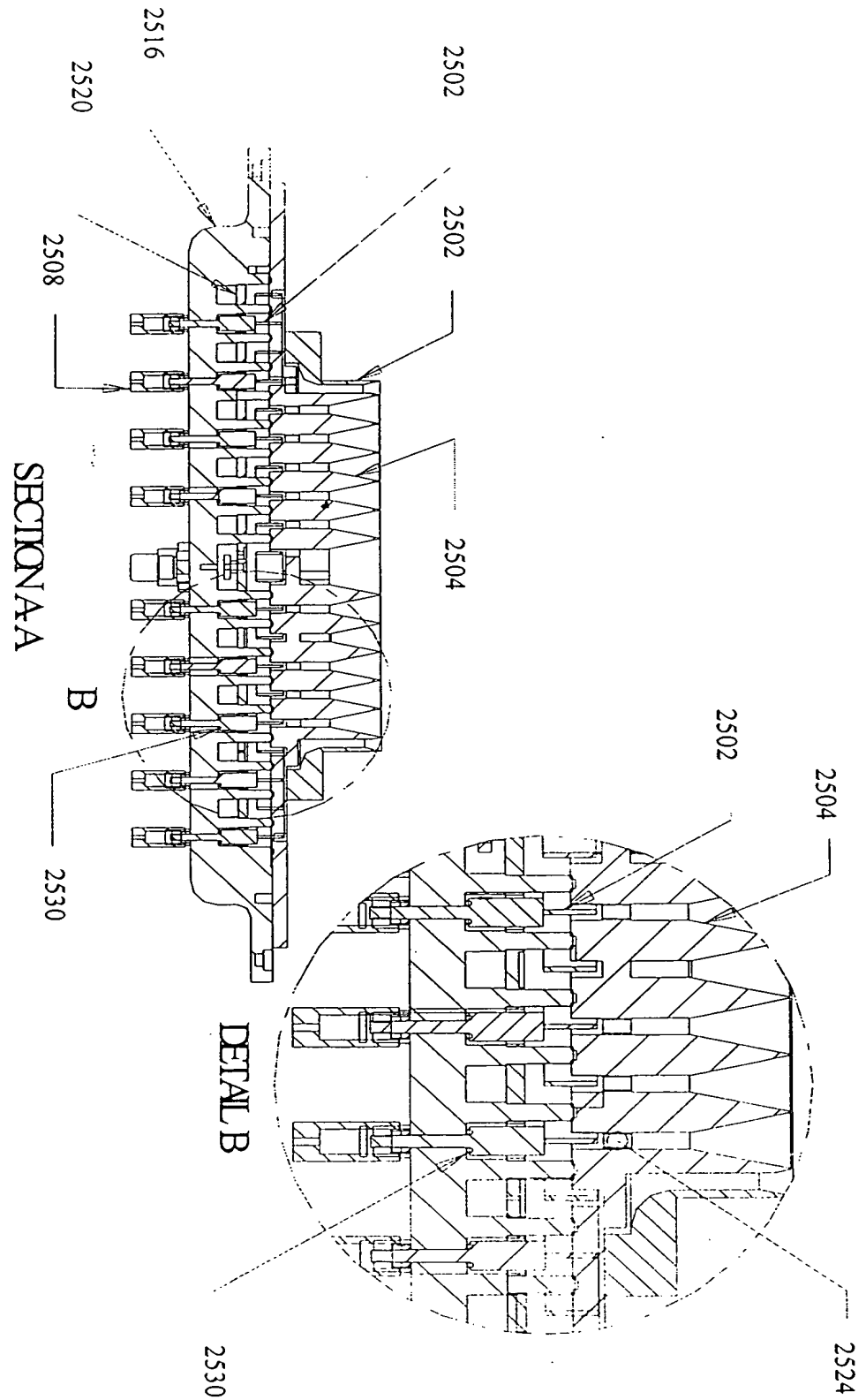


Fig. 25E

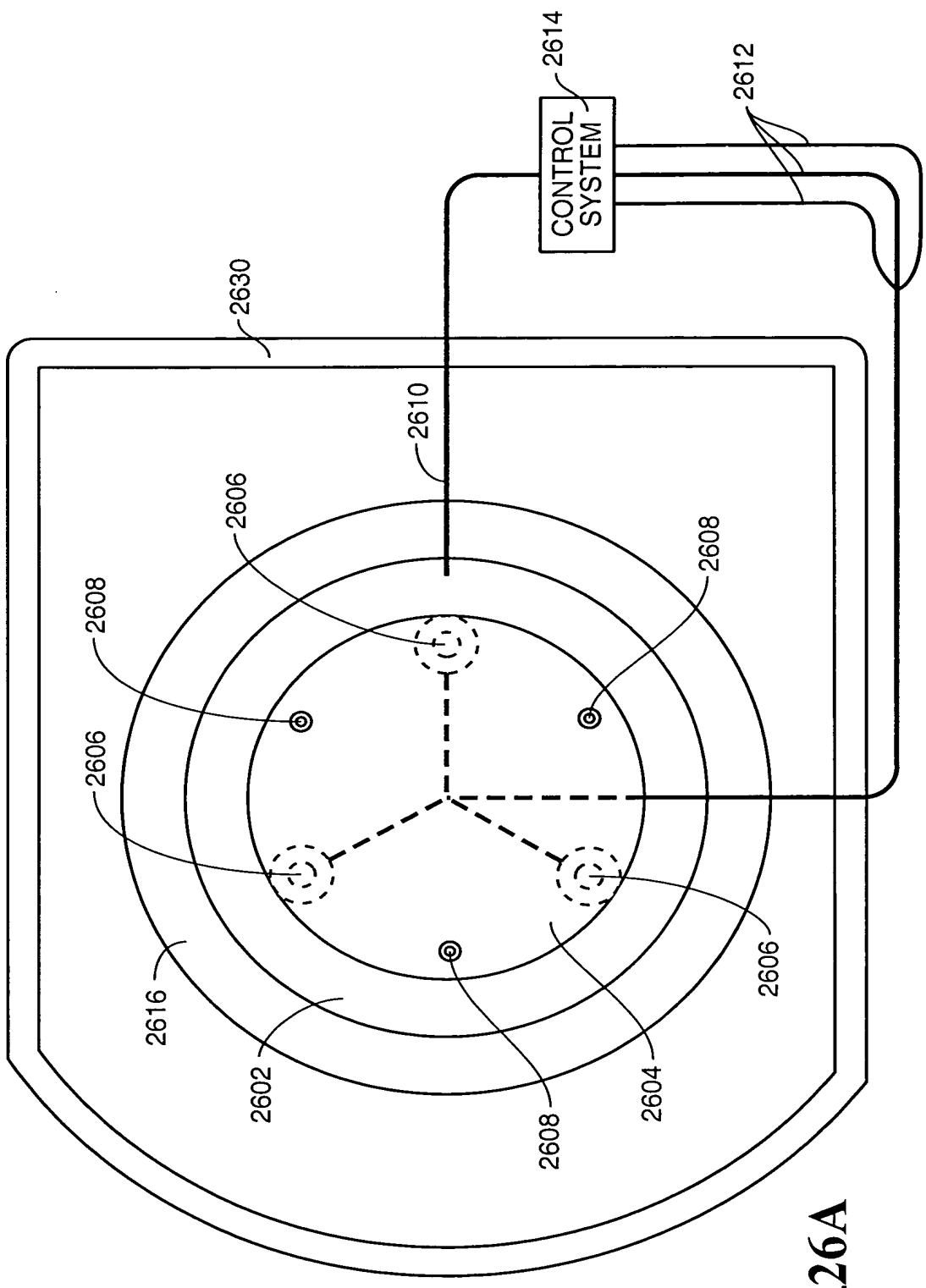


FIG. 26A

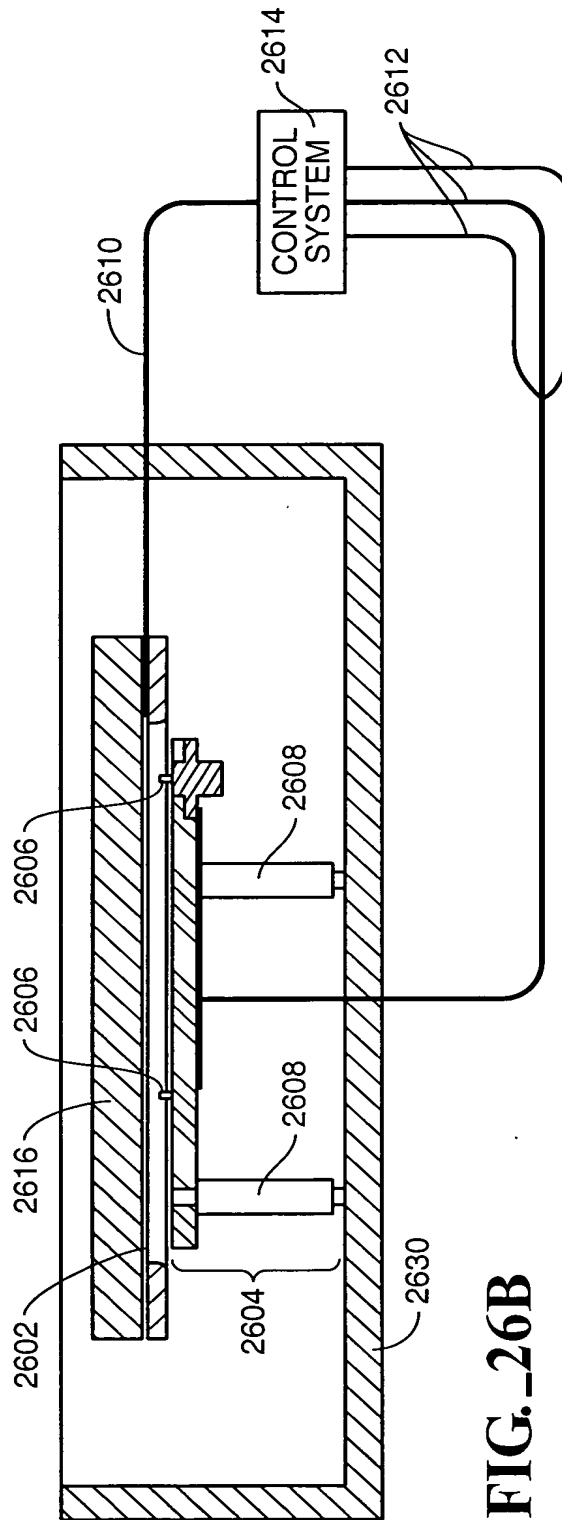
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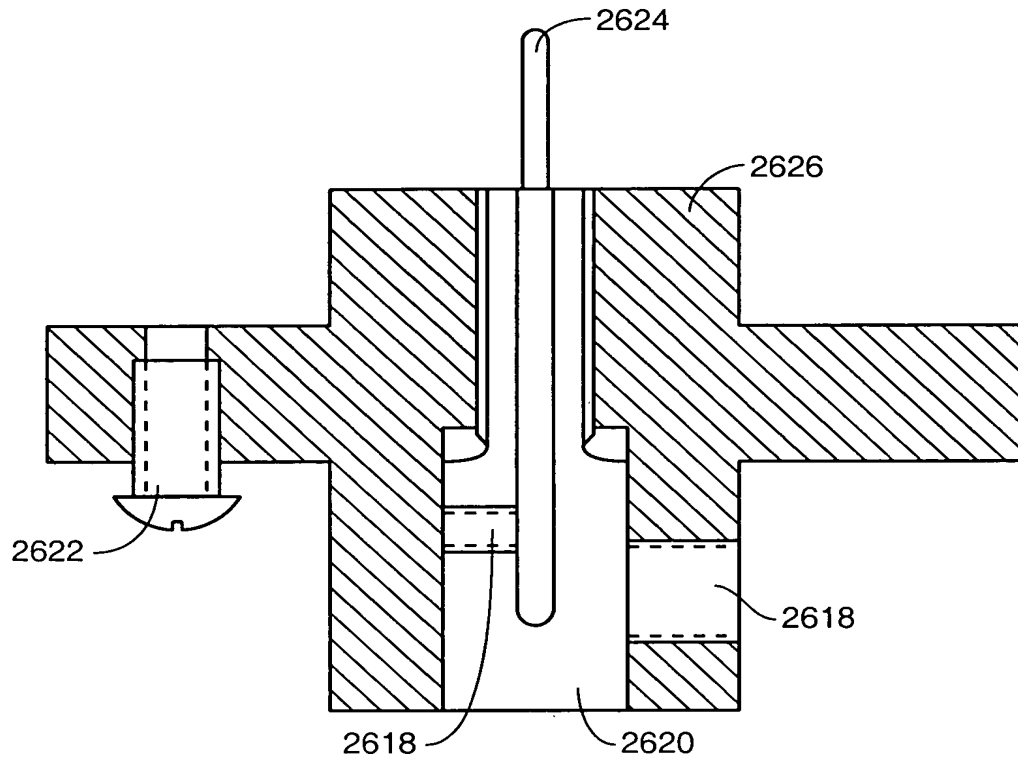
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**FIG. 26C**

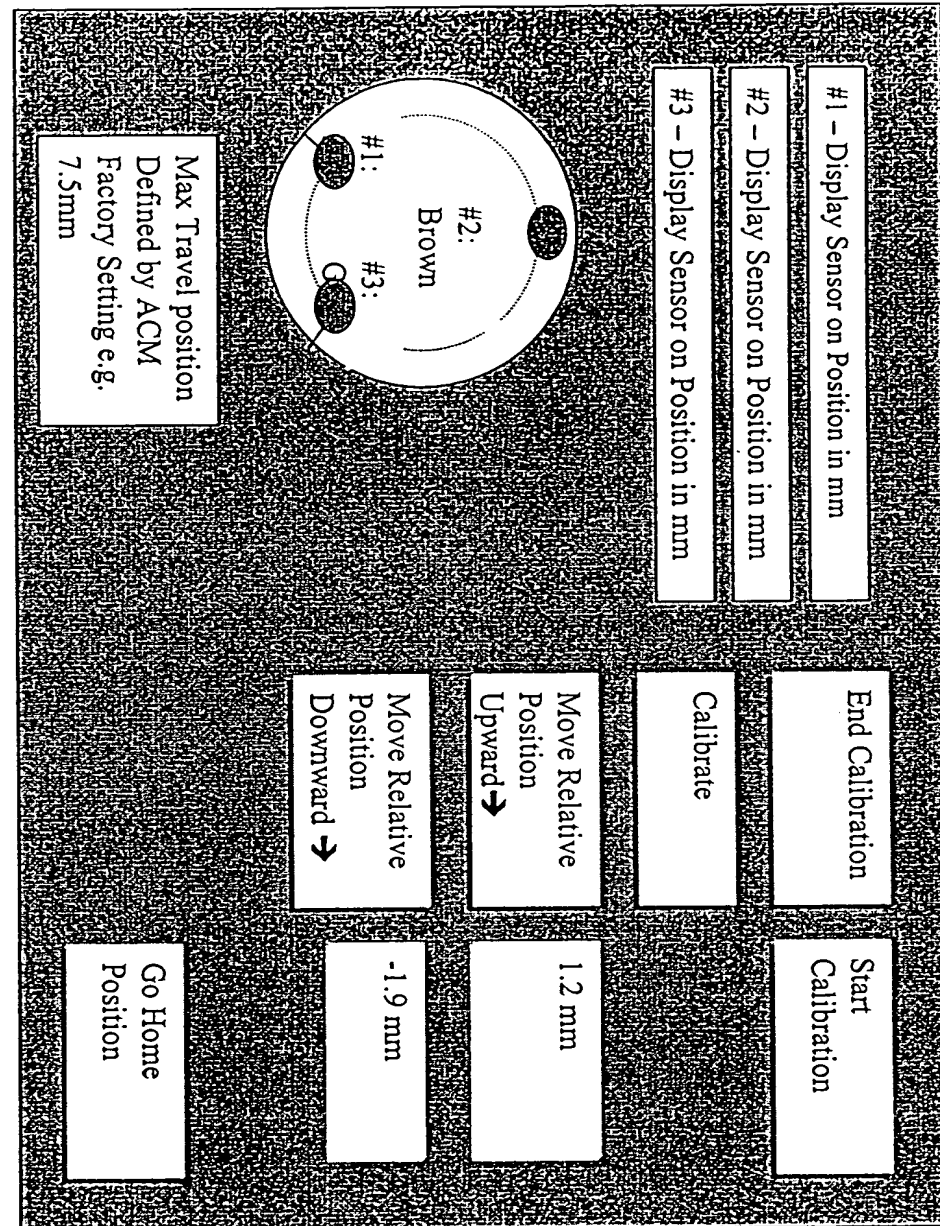


Fig. 27